

# TAD5142 110dB のダイナミックレンジを持ち、ヘッドホン/ラインドライバを備えたハードウェア制御ステレオ オーディオ DAC

## 1 特長

- – ステレオ オーディオ DAC の性能:
  - DAC から差動ライン出力までのダイナミックレンジ: 110dB
  - DAC から疑似差動ヘッドホン出力までのダイナミックレンジ: 107dB
  - DAC から差動ライン出力までの THD+N: -100dB
  - 出力電圧:
    - 差動ライン出力 / レシーバ、 $2V_{RMS}$  フルスケール
    - 疑似差動ヘッドホン、 $1V_{RMS}$  フルスケール
    - シングルエンドライン出力、 $1V_{RMS}$  フルスケール
  - DAC サンプル レート ( $f_s$ ) = 8kHz~192kHz
- 主な特長
  - ピンまたはハードウェア制御
  - オーディオ シリアル インターフェイス
    - フォーマット: TDM、LJ または I<sup>2</sup>S
    - バス コントローラおよびターゲット モード
    - TDM モードのデジタイゼーション
    - ワード長: 24 ビットまたは 32 ビットを選択可能
  - ピンで選択可能なデジタル補間フィルタ オプション:
    - リニア位相
    - 低レイテンシ
  - 自動クロック検出
  - クロック エラー時の割り込み出力
  - 単一電源動作 AVDD: 1.8V または 3.3V
  - I/O 電源動作: 1.8V または 3.3V
  - 温度グレード 1: -40°C ≤ T<sub>A</sub> ≤ +125°C

## 2 アプリケーション

- AV レシーバ
- IP ネットワーク カメラ
- サウンドバー
- テレビ会議システム

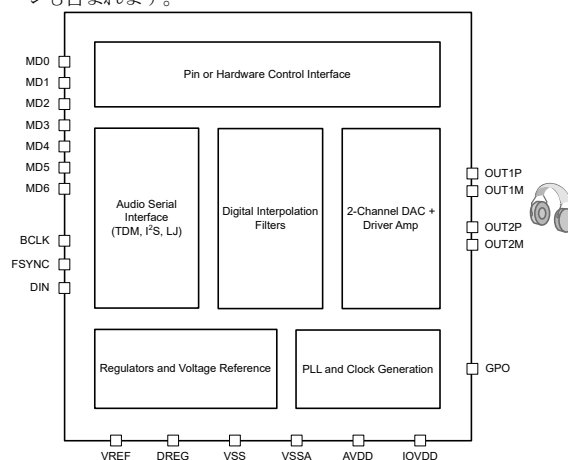
## 3 概要

TAD5142 は、ライン出力とヘッドホン負荷のどちらにも構成でき、シングルエンド出力と差動出力の両方をサポートしている、 $2V_{RMS}$ 、110dB のステレオ オーディオ DAC です。本デバイスはフェーズ ロック ループ (PLL) を内蔵しており、最大 192kHz のサンプル レートに対応しています。TAD5142 は、 $16\Omega$  のヘッドホン負荷を最大 62.5mW で駆動できます。TAD5142 は、コントローラおよびターゲット モードの時分割多重化 (TDM)、左揃え (LJ)、I<sup>2</sup>S オーディオ フォーマットをサポートしており、ピンまたはハードウェアで制御できます。このように高性能な機能、ピン制御、そして単一電源動作であるため、TAD5142 はスペースに制約のあるオーディオ アプリケーションに最適な選択肢となっています。

### 製品情報

| 部品番号    | パッケージ (1) | パッケージ サイズ (公称) (2)  |
|---------|-----------|---------------------|
| TAD5142 | VQFN (24) | 4mm × 4mm、0.5mm ピッチ |

- (1) 利用可能なすべてのパッケージについては、データシートの末尾にある注文情報を参照してください。
- (2) パッケージ サイズ (長さ × 幅) は公称値であり、該当する場合はピンも含まれます。



概略ブロック図



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## 4 Pin Configuration and Functions

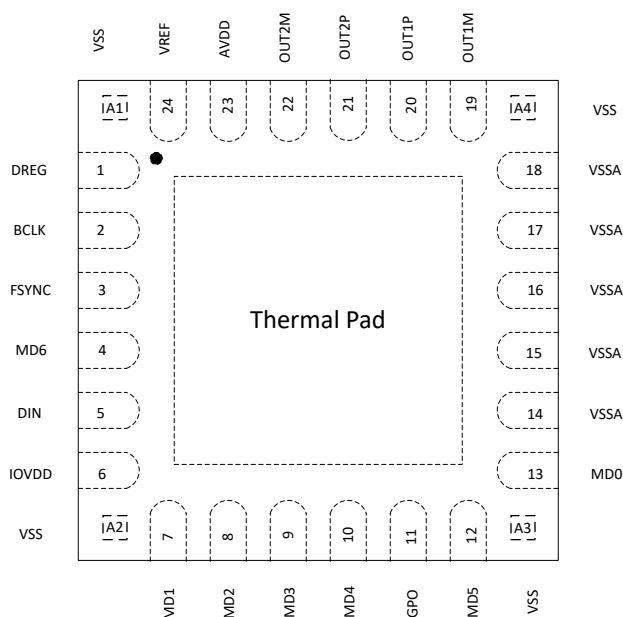


図 4-1. 24-Pin QFN Package with Exposed Thermal Pad and Corner Pins, Top View

表 4-1. Pin Functions

| PIN   |     | TYPE           | DESCRIPTION  |
|-------|-----|----------------|--|
| NAME  | NO. |                |  |
| VSS   | A1  | Ground         | Ground pin. Short directly to board ground plane.  |
| DREG  | 1   | Digital Supply | Digital on-chip regulator output voltage for digital supply (1.55V, nominal)   |
| BCLK  | 2   | Digital I/O    | Audio serial data interface bus bit clock  |
| FSYNC | 3   | Digital I/O    | Audio serial data interface bus frame synchronization signal   |
| MD6   | 4   | Digital I/O    | TDM mode: Daisy chain output<br>I <sup>2</sup> S/LJ mode: Mono/Stereo DAC Channels selection   |
| DIN   | 5   | Digital Input  | Audio serial data interface bus input  |
| IOVDD | 6   | Digital Supply | Digital I/O power supply (1.8V or 3.3V, nominal)   |
| VSS   | A2  | Ground         | Ground pin. Short directly to board ground plane.  |
| MD1   | 7   | Digital Input  | Controller mode: Frame rate and BCLK frequency selection<br>Target mode: AVDD supply, word length, and interpolation filter type selection |
| MD2   | 8   | Digital Input  | Controller mode: Frame rate and BCLK frequency selection<br>Target mode: AVDD supply, word length, and interpolation filter type selection |
| MD3   | 9   | Digital Input  | Controller mode: Controller clock input<br>Target mode: Short directly to board ground plane.  |
| MD4   | 10  | Digital Input  | DAC output configuration selection   |
| GPO   | 11  | Digital Output | Interrupt output (latched)   |

表 4-1. Pin Functions (続き)

| PIN   |     | TYPE          | DESCRIPTION  |
|-------|-----|---------------|--|
| NAME  | NO. |               |  |
| MD5   | 12  | Digital Input | DAC output configuration selection   |
| VSS   | A3  | Ground        | Ground pin. Short directly to board ground plane.  |
| MD0   | 13  | Analog Input  | Multi-level analog input for controller/target mode and I <sup>2</sup> S/TDM/LJ mode selection |
| VSSA  | 14  | Ground        | Short directly to board ground plane   |
| VSSA  | 15  | Ground        | Short directly to board ground plane   |
| VSSA  | 16  | Ground        | Short directly to board ground plane   |
| VSSA  | 17  | Ground        | Short directly to board ground plane   |
| VSSA  | 18  | Ground        | Short directly to board ground plane   |
| VSS   | A4  | Ground        | Ground pin. Short directly to board ground plane.  |
| OUT1M | 19  | Analog Output | Analog output 1M pin   |
| OUT1P | 20  | Analog Output | Analog output 1P pin   |
| OUT2P | 21  | Analog Output | Analog output 2P pin   |
| OUT2M | 22  | Analog Output | Analog output 2M pin   |
| AVDD  | 23  | Analog Supply | Analog power supply (1.8V or 3.3V, nominal)  |
| VREF  | 24  | Analog        | Analog reference voltage filter output   |

## 5 Specifications

### 5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                            |   | MIN  | MAX         | UNIT |
|----------------------------|---|------|-------------|------|
| Supply voltage             | AVDD to VSS (thermal pad)                       | −0.3 | 3.9         | V    |
| Supply voltage             | IOVDD to VSS (thermal pad)                      | −0.3 | 3.9         | V    |
| Ground voltage differences | VSSA to VSS (thermal pad)                       | −0.3 | 0.3         | V    |
| Digital input voltage      | Digital input pins voltage to VSS (thermal pad) | −0.3 | IOVDD + 0.3 | V    |
| Temperature                | Functional ambient, T <sub>A</sub>              | −55  | 125         | °C   |
|                            | Operating ambient, T <sub>A</sub>               | −40  | 125         |      |
|                            | Junction, T <sub>J</sub>                        | −40  | 150         |      |
|                            | Storage, T <sub>stg</sub>                       | −65  | 150         |      |

- (1) Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.

### 5.2 ESD Ratings

|                    |                         |   | VALUE | UNIT |
|--------------------|-------------------------|---|-------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>     | ±2000 | V    |
| V <sub>(ESD)</sub> | Electrostatic discharge | Charged-device model (CDM), per ANSI/ESDA/JEDEC JS-002 <sup>(2)</sup> | ±500  |      |

- (1) JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.  
(2) JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.

### 5.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                     |  | MIN  | NOM | MAX   | UNIT |
|---------------------|--|------|-----|-------|------|
| POWER               |  |      |     |       |      |
| AVDD <sup>(1)</sup> | Analog supply voltage to VSS (thermal pad) - AVDD 3.3V operation | 3.0  | 3.3 | 3.6   | V    |
|                     | Analog supply voltage to VSS (thermal pad) - AVDD 1.8V operation | 1.65 | 1.8 | 1.95  |      |
| IOVDD               | IO supply voltage to VSS (thermal pad) - IOVDD 3.3V operation    | 3.0  | 3.3 | 3.6   | V    |
|                     | IO supply voltage to VSS (thermal pad) - IOVDD 1.8V operation    | 1.65 | 1.8 | 1.95  |      |
| INPUTS              |  |      |     |       |      |
| IO                  | Digital input pins (MD1 to MD6) voltage to VSS (thermal pad)     | 0    |     | IOVDD | V    |
| MD0                 | MD0 pin w.r.t VSS (thermal pad)                                  | 0    |     | AVDD  | V    |
| TEMPERATURE         |  |      |     |       |      |
| T <sub>A</sub>      | Operating ambient temperature                                    | −40  |     | 125   | °C   |

over operating free-air temperature range (unless otherwise noted)

|                |   | MIN | NOM | MAX                   | UNIT |
|----------------|---|-----|-----|-----------------------|------|
| <b>OTHERS</b>  |   |     |     |                       |      |
| CCLK           | MD3 controller mode clock frequency (CCLK) - IOVDD 3.3V operation |     |     | 36.864 <sup>(2)</sup> | MHz  |
|                | MD3 controller mode clock frequency (CCLK) - IOVDD 1.8V operation |     |     | 24.576 <sup>(2)</sup> |      |
| C <sub>L</sub> | Digital output load capacitance                                   |     | 20  | 50                    | pF   |

- (1) VSSA and VSS (thermal pad); all ground pins must be tied together and must not differ in voltage by more than 0.2V.  
 (2) CCLK input rise time (V<sub>IL</sub> to V<sub>IH</sub>) and fall time (V<sub>IH</sub> to V<sub>IL</sub>) must be less than 5ns. For better audio noise performance, CCLK input must be used with low jitter.

## 5.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |  | TAD5142    | UNIT |
|-------------------------------|--|------------|------|
|                               |  | RGE (VQFN) |      |
|                               |  | 24 PINS    |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 38.4       | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 26.3       | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 15.9       | °C/W |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 0.5        | °C/W |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 15.8       | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | 13.8       | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 5.5 Electrical Characteristics

At T<sub>A</sub> = 25°C, AVDD = 3.3V, IOVDD = 3.3V, f<sub>IN</sub> = 1kHz sinusoidal signal, f<sub>S</sub> = 48kHz, 32-bit audio data, BCLK = 256 × f<sub>S</sub>, TDM target mode, and linear phase interpolation filter, with 1200Ω/600Ω line-out load in differential/single-ended configuration or 32Ω receiver differential load as applicable; measured filter free with an Audio Precision with a 20Hz to 20kHz un-weighted bandwidth, unless otherwise noted

| PARAMETER  | TEST CONDITIONS   | MIN | NOM | MAX | UNIT             |
|--|---|-----|-----|-----|------------------|
| <b>DAC Performance for Line Output/Head Phone Playback</b> |   |     |     |     |                  |
| Full Scale Output Voltage                                  | Differential output between OUTxP and OUTxM, AVDD = 3.3V  |     | 2   |     | V <sub>RMS</sub> |
|  | Differential output between OUTxP and OUTxM, AVDD = 1.8V  |     | 1   |     |                  |
|  | Single-ended output, AVDD = 3.3V  |     | 1   |     |                  |
|  | Single-ended output, AVDD = 1.8V  |     | 0.5 |     |                  |
|  | Pseudo-differential output between OUTxP and OUT1M with external common-mode sense, AVDD = 3.3V |     | 1   |     |                  |
|  | Pseudo-differential output between OUTxP and OUT1M with external common-mode sense, AVDD = 1.8V |     | 0.5 |     |                  |
| SNR  | Differential output, 0dBFS Signal, AVDD = 3.3V  |     | 110 |     | dB               |
|  | Single-ended output, 0dBFS Signal, AVDD = 3.3V  |     | 107 |     |                  |
|  | Pseudo-differential output, 0dBFS Signal, AVDD = 3.3V   |     | 107 |     |                  |
|  | Differential output, 0dBFS Signal, AVDD = 1.8V  |     | 109 |     |                  |
|  | Single-ended output, 0dBFS Signal, AVDD = 1.8V  |     | 104 |     |                  |
|  | Pseudo-differential output, 0dBFS Signal, AVDD = 1.8V   |     | 103 |     |                  |

At  $T_A = 25^\circ\text{C}$ ,  $AVDD = 3.3\text{V}$ ,  $IOVDD = 3.3\text{V}$ ,  $f_{IN} = 1\text{kHz}$  sinusoidal signal,  $f_S = 48\text{kHz}$ , 32-bit audio data,  $BCLK = 256 \times f_S$ , TDM target mode, and linear phase interpolation filter, with  $1200\Omega/600\Omega$  line-out load in differential/single-ended configuration or  $32\Omega$  receiver differential load as applicable; measured filter free with an Audio Precision with a 20Hz to 20kHz un-weighted bandwidth, unless otherwise noted

| PARAMETER                           |  | TEST CONDITIONS   | MIN            | NOM      | MAX            | UNIT     |
|-------------------------------------|--|---|----------------|----------|----------------|----------|
| DR                                  | Dynamic range, A-weighted <sup>(2)</sup>         | Differential output, –60dBFS Signal, $AVDD = 3.3\text{V}$                                     |                | 110      |                | dB       |
|                                     |  | Single-ended output, –60dBFS Signal, $AVDD = 3.3\text{V}$                                     |                | 107      |                |          |
|                                     |  | Pseudo-differential output, –60dBFS Signal, $AVDD = 3.3\text{V}$                              |                | 107      |                |          |
|                                     |  | Differential output, –60dBFS Signal, $AVDD = 1.8\text{V}$                                     |                | 109      |                |          |
|                                     |  | Single-ended output, –60dBFS Signal, $AVDD = 1.8\text{V}$                                     |                | 104      |                |          |
|                                     |  | Pseudo-differential output, –60dBFS Signal, $AVDD = 1.8\text{V}$                              |                | 103      |                |          |
| THD+N                               | Total harmonic distortion <sup>(2)</sup>         | Differential output, –1dBFS Signal, $AVDD = 3.3\text{V}$                                      |                | –100     |                | dB       |
| THD+N                               | Total harmonic distortion <sup>(2)</sup>         | Single-ended output, –1dBFS Signal, $AVDD = 3.3\text{V}$                                      |                | –96      |                | dB       |
|                                     | Headphone Load Range <sup>(3)</sup>              |   | 8              | 16       | 300            | $\Omega$ |
|                                     | Headphone/Line-out Cap Load                      |   | 0              | 100      | 550            | pF       |
|                                     | Line-out Load Range                              |   | 600            |          |                | $\Omega$ |
| <b>DAC Channel OTHER PARAMETERS</b> |  |   |                |          |                |          |
|                                     | Output Offset                                    | 0 Input, Differential Line-output   |                | 0.5      |                | mV       |
|                                     | Output Common Mode                               | Common Mode Level for OUTxP and OUTxM, $AVDD = 1.8\text{V}$                                   |                | 0.9      |                | V        |
|                                     | Output Common Mode                               | Common Mode Level for OUTxP and OUTxM, $AVDD = 3.3\text{V}$                                   |                | 1.65     |                | V        |
|                                     | Common Mode Error                                | DC Error in Common Mode Voltage   |                | $\pm 10$ |                | mV       |
|                                     | Output Signal Bandwidth                          |   |                | 20       |                | kHz      |
|                                     | Input data word length                           | Pin-selectable  | 24             |          | 32             | Bits     |
|                                     | Interchannel isolation                           |   |                | –120     |                | dB       |
|                                     | Gain Error                                       |   |                | 0.1      |                | dB       |
|                                     | Interchannel gain mismatch                       |   |                | 0.1      |                | dB       |
|                                     | Interchannel phase mismatch                      | 1kHz sinusoidal signal  |                | 0.01     |                | Degrees  |
| PSRR                                | Power-supply rejection ratio                     | 100mV <sub>PP</sub> , 1kHz sinusoidal signal on $AVDD$ , differential input, 0dB channel gain |                | 110      |                | dB       |
| P <sub>out</sub>                    | Output Power Delivery                            | Receiver/Headphone $R_L = 16\Omega$ , THD+N < 1% in Differential or Pseudo-differential mode  |                | 62.5     |                | mW       |
| <b>DIGITAL I/O</b>                  |  |   |                |          |                |          |
| V <sub>IL</sub>                     | Low-level digital input logic voltage threshold  | All digital pins, $IOVDD$ 1.8V operation  | –0.3           |          | 0.35 x $IOVDD$ | V        |
|                                     |  | All digital pins, $IOVDD$ 3.3V operation  | –0.3           |          | 0.8            |          |
| V <sub>IH</sub>                     | High-level digital input logic voltage threshold | All digital pins, $IOVDD$ 1.8V operation  | 0.65 x $IOVDD$ |          | $IOVDD + 0.3$  | V        |
|                                     |  | All digital pins, $IOVDD$ 3.3V operation  | 2              |          | $IOVDD + 0.3$  |          |

At  $T_A = 25^\circ\text{C}$ ,  $AVDD = 3.3\text{V}$ ,  $IOVDD = 3.3\text{V}$ ,  $f_{IN} = 1\text{kHz}$  sinusoidal signal,  $f_S = 48\text{kHz}$ , 32-bit audio data,  $BCLK = 256 \times f_S$ , TDM target mode, and linear phase interpolation filter, with  $1200\Omega/600\Omega$  line-out load in differential/single-ended configuration or  $32\Omega$  receiver differential load as applicable; measured filter free with an Audio Precision with a 20Hz to 20kHz un-weighted bandwidth, unless otherwise noted

| PARAMETER                                 |   | TEST CONDITIONS  | MIN            | NOM  | MAX  | UNIT          |
|---|---|--|----------------|------|------|---------------|
| $V_{OL}$                                  | Low-level digital output voltage  | All digital pins, $I_{OL} = -2\text{ mA}$ , $IOVDD\ 1.8\text{V}$ operation |                |      | 0.45 | V             |
|   |   | All digital pins, $I_{OL} = -2\text{ mA}$ , $IOVDD\ 3.3\text{V}$ operation |                |      | 0.4  |               |
| $V_{OH}$                                  | High-level digital output voltage   | All digital pins, $I_{OH} = 2\text{ mA}$ , $IOVDD\ 1.8\text{V}$ operation  | $IOVDD - 0.45$ |      |      | V             |
|   |   | All digital pins, $I_{OH} = 2\text{ mA}$ , $IOVDD\ 3.3\text{V}$ operation  | 2.4            |      |      |               |
| $I_{IL}$                                  | Input logic-low leakage for digital inputs  | All digital pins, input = 0V   | -5             | 0.1  | 5    | $\mu\text{A}$ |
| $I_{IH}$                                  | Input logic-high leakage for digital inputs   | All digital pins, input = $IOVDD$  | -5             | 0.1  | 5    | $\mu\text{A}$ |
| $C_{IN}$                                  | Input capacitance for digital inputs  | All digital pins   |                | 5    |      | pF            |
| $R_{PD}$                                  | Pulldown resistance for digital I/O pins when asserted on   |  |                | 20   |      | k $\Omega$    |
| <b>TYPICAL SUPPLY CURRENT CONSUMPTION</b> |   |  |                |      |      |               |
| $I_{AVDD}$                                | Current consumption in sleep mode or low power mode   | All external clocks stopped with MD3 pin grounded, $AVDD = 3.3\text{V}$    |                | 0.8  |      | mA            |
| $I_{IOVDD}$                               |   | All external clocks stopped with MD3 pin grounded, $IOVDD = 3.3\text{V}$   |                | 0.6  |      | $\mu\text{A}$ |
| $I_{IOVDD}$                               |   | All external clocks stopped with MD3 pin grounded, $IOVDD = 1.8\text{V}$   |                | 0.2  |      |               |
| $I_{AVDD}$                                | Current consumption with DAC to Headphone 2-channel operation at $f_S\ 16\text{kHz}$ , I <sup>2</sup> S Target Mode, $BCLK = 64 \times f_S$ | $AVDD = 3.3\text{V}$   |                | 16.4 |      | mA            |
| $I_{IOVDD}$                               |   | $IOVDD = 3.3\text{V}$  |                | 0.06 |      |               |
| $I_{IOVDD}$                               |   | $IOVDD = 1.8\text{V}$  |                | 0.03 |      |               |
| $I_{AVDD}$                                | Current consumption with DAC to Headphone 2-channel operation at $f_S\ 48\text{kHz}$ , I <sup>2</sup> S Target Mode, $BCLK = 64 \times f_S$ | $AVDD = 3.3\text{V}$   |                | 20   |      | mA            |
| $I_{IOVDD}$                               |   | $IOVDD = 3.3\text{V}$  |                | 0.06 |      |               |
| $I_{IOVDD}$                               |   | $IOVDD = 1.8\text{V}$  |                | 0.03 |      |               |
| $I_{AVDD}$                                | Current consumption with DAC to Line-out 2-channel operation at $f_S\ 16\text{kHz}$ , I <sup>2</sup> S Target Mode, $BCLK = 64 \times f_S$  | $AVDD = 3.3\text{V}$   |                | 16.4 |      | mA            |
| $I_{AVDD}$                                | Current consumption with DAC to Line-out 2-channel operation at $f_S\ 48\text{kHz}$ , I <sup>2</sup> S Target Mode, $BCLK = 64 \times f_S$  | $AVDD = 3.3\text{V}$   |                | 17   |      | mA            |
| $I_{IOVDD}$                               |   | $IOVDD = 3.3\text{V}$  |                | 0.06 |      |               |
| $I_{IOVDD}$                               |   | $IOVDD = 1.8\text{V}$  |                | 0.02 |      |               |

- (1) Ratio of output level with 1kHz full-scale sine-wave input, to the output level with no generator input signal and input shorted to ground, measured with an A-weighted filter over a 20Hz to 20kHz bandwidth
- (2) All performance measurements done with 20kHz low-pass filter and, where noted, an A-weighted filter. Failure to use such a filter can result in higher THD+N and lower SNR and dynamic range readings than shown in the Electrical Characteristics. The low-pass filter removes out-of-band noise, which, although not audible, can affect dynamic specification values.
- (3) For headphone loads  $<32\Omega$ , input signal level should be limited as per the output power delivery specifications.



## 5.6 Timing Requirements: TDM, I<sup>2</sup>S or LJ Interface

at T<sub>A</sub> = 25°C, IOVDD = 3.3V or 1.8V and 20pF load on all outputs (unless otherwise noted), see Figure 5-1 for timing diagram where DOUT refers to Daisy Chain Output when applicable

|                         |   |                                   | MIN | NOM | MAX | UNIT |
|-------------------------|---|-----------------------------------|-----|-----|-----|------|
| t <sub>(BCLK)</sub>     | BCLK period                             | IOVDD = 1.8V                      | 80  |     |     | ns   |
|                         |   | IOVDD = 3.3V                      | 40  |     |     |      |
| t <sub>H(BCLK)</sub>    | BCLK high pulse duration <sup>(1)</sup> | IOVDD = 1.8V                      | 36  |     |     | ns   |
|                         |   | IOVDD = 3.3V                      | 18  |     |     |      |
| t <sub>L(BCLK)</sub>    | BCLK low pulse duration <sup>(1)</sup>  | IOVDD = 1.8V                      | 36  |     |     | ns   |
|                         |   | IOVDD = 3.3V                      | 18  |     |     |      |
| t <sub>SU(FSYNC)</sub>  | FSYNC setup time                        | IOVDD = 1.8V                      | 8   |     |     | ns   |
|                         |   | IOVDD = 3.3V                      | 8   |     |     |      |
| t <sub>HLD(FSYNC)</sub> | FSYNC hold time                         | IOVDD = 1.8V                      | 8   |     |     | ns   |
|                         |   | IOVDD = 3.3V                      | 8   |     |     |      |
| t <sub>SU(DIN)</sub>    | DIN setup time                          | IOVDD = 1.8V                      | 8   |     |     | ns   |
|                         |   | IOVDD = 3.3V                      | 8   |     |     |      |
| t <sub>HLD(DIN)</sub>   | DIN hold time                           | IOVDD = 1.8V                      | 16  |     |     | ns   |
|                         |   | IOVDD = 3.3V                      | 8   |     |     |      |
| t <sub>r(BCLK)</sub>    | BCLK rise time                          | 10% - 90% rise time, IOVDD = 1.8V |     |     | 10  | ns   |
|                         |   | 10% - 90% rise time, IOVDD = 3.3V |     |     | 10  |      |
| t <sub>f(BCLK)</sub>    | BCLK fall time                          | 90% - 10% fall time, IOVDD = 1.8V |     |     | 10  | ns   |
|                         |   | 90% - 10% fall time, IOVDD = 3.3V |     |     | 10  |      |

(1) To meet the timing specifications, the BCLK minimum high or low pulse duration must be higher than 25ns, if the DOUT data line is latched on the opposite BCLK edge polarity from the one used by the device to transmit the DOUT data at IOVDD = 3.3V.

## 5.7 Switching Characteristics: TDM, I<sup>2</sup>S or LJ Interface

at T<sub>A</sub> = 25°C, IOVDD = 3.3V or 1.8V and 20pF load on all outputs (unless otherwise noted); see Figure 5-1 for timing diagram where DOUT refers to Daisy Chain Output when applicable

|                            | PARAMETER   | TEST CONDITIONS                           | MIN | TYP | MAX    | UNIT |
|----------------------------|---|---|-----|-----|--------|------|
| t <sub>d(DOUT-BCLK)</sub>  | BCLK to DOUT delay  | 50% of BCLK to 50% of DOUT, IOVDD = 1.8V  |     |     | 26     | ns   |
|                            |   | 50% of BCLK to 50% of DOUT, IOVDD = 3.3V  |     |     | 19     |      |
| t <sub>d(DOUT-FSYNC)</sub> | FSYNC to DOUT delay in TDM mode                             | 50% of FSYNC to 50% of DOUT, IOVDD = 1.8V |     |     | 26     | ns   |
|                            | FSYNC to DOUT delay in TDM mode                             | 50% of FSYNC to 50% of DOUT, IOVDD = 3.3V |     |     | 19     |      |
| f <sub>(BCLK)</sub>        | BCLK output clock frequency; controller mode <sup>(1)</sup> | IOVDD = 1.8V                              |     |     | 12.288 | MHz  |
|                            |   | IOVDD = 3.3V                              |     |     | 24.576 |      |
| t <sub>d(FSYNC)</sub>      | BCLK to FSYNC delay; controller mode                        | 50% of BCLK to 50% of FSYNC, IOVDD = 1.8V |     |     | 26     | ns   |
|                            |   | 50% of BCLK to 50% of FSYNC, IOVDD = 3.3V |     |     | 19     |      |
| t <sub>H(BCLK)</sub>       | BCLK high pulse duration; controller mode                   | IOVDD = 1.8V                              | 36  |     |        | ns   |
|                            |   | IOVDD = 3.3V                              | 18  |     |        |      |
| t <sub>L(BCLK)</sub>       | BCLK low pulse duration; controller mode                    | IOVDD = 1.8V                              | 36  |     |        | ns   |
|                            |   | IOVDD = 3.3V                              | 18  |     |        |      |
| t <sub>r(BCLK)</sub>       | BCLK rise time; controller mode                             | 10% - 90% rise time, IOVDD = 1.8V         |     |     | 10     | ns   |
|                            |   | 10% - 90% rise time, IOVDD = 3.3V         |     |     | 10     |      |

at  $T_A = 25^\circ\text{C}$ , IOVDD = 3.3V or 1.8V and 20pF load on all outputs (unless otherwise noted); see Figure 5-1 for timing diagram where DOUT refers to Daisy Chain Output when applicable

| PARAMETER            | TEST CONDITIONS  | MIN | TYP | MAX | UNIT |
|----------------------|--|-----|-----|-----|------|
| $t_{f(\text{BCLK})}$ | BCLK fall time; controller mode<br>90% - 10% fall time, IOVDD = 1.8V |     |     | 10  | ns   |
|                      | 90% - 10% fall time, IOVDD = 3.3V                                    |     |     | 10  |      |

- (1) To meet the timing specifications, the BCLK output clock frequency must be lower than 18.5MHz, if the DOUT data line is latched on the opposite BCLK edge polarity from the one used by the device to transmit DOUT data at IOVDD = 3.3V.

## 5.8 Timing Diagrams

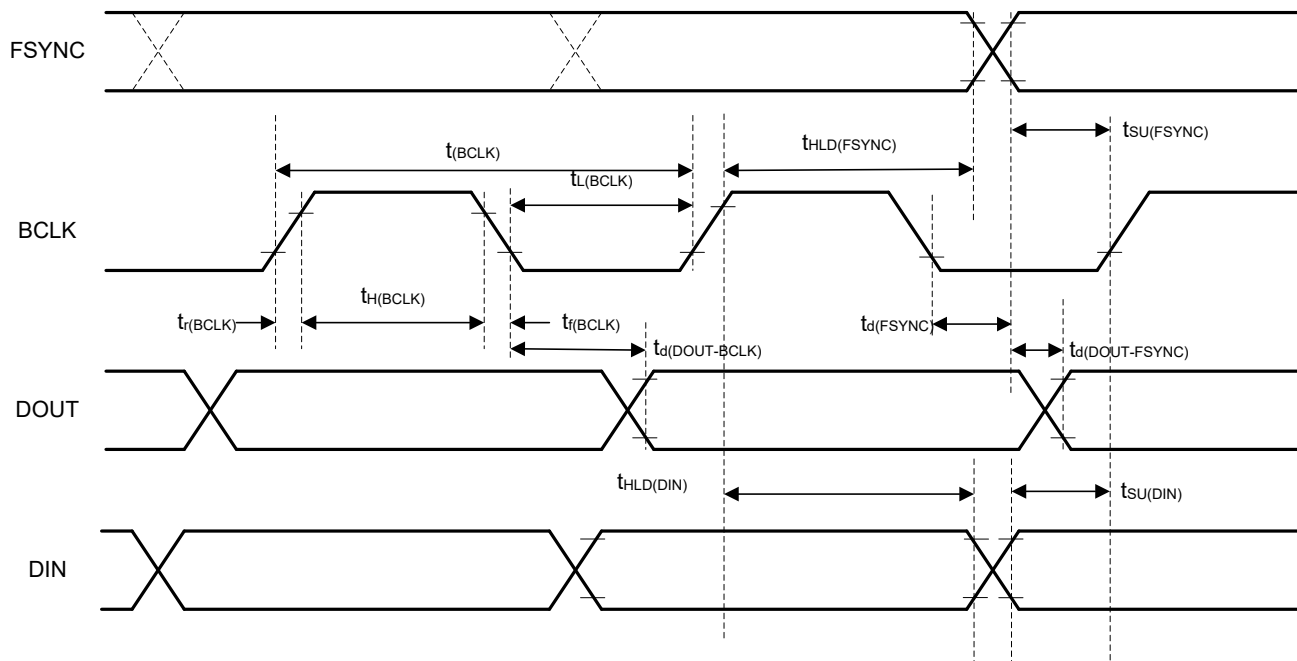


图 5-1. TDM, I²S, and LJ Interface Timing Diagram

## 5.9 Typical Characteristics

At  $T_A = 25^\circ\text{C}$ ,  $AVDD = 3.3\text{V}$ ,  $IOVDD = 3.3\text{V}$ ,  $f_{IN} = 1\text{kHz}$  sinusoidal signal,  $f_S = 48\text{kHz}$ , 32-bit audio data,  $BCLK = 256 \times f_S$ , TDM target mode, and linear phase interpolation filter, with  $1200\Omega/600\Omega$  line-out load in differential/single-ended configuration or  $32\Omega$  receiver differential load as applicable; measured filter free with an Audio Precision with a 20Hz to 20kHz un-weighted bandwidth, unless otherwise noted

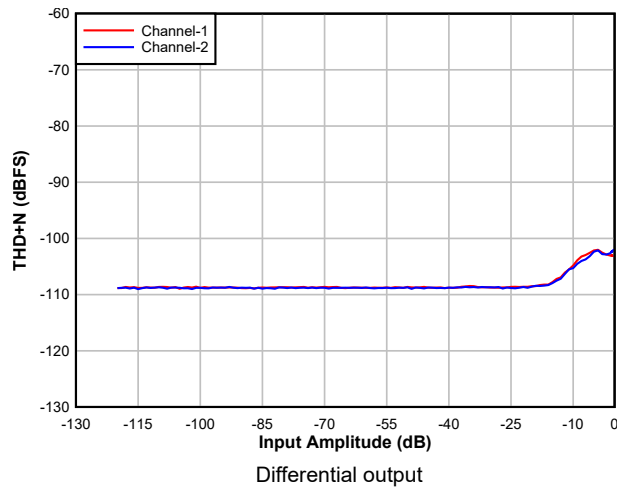


Figure 5-2. DAC THD+N Level vs Input

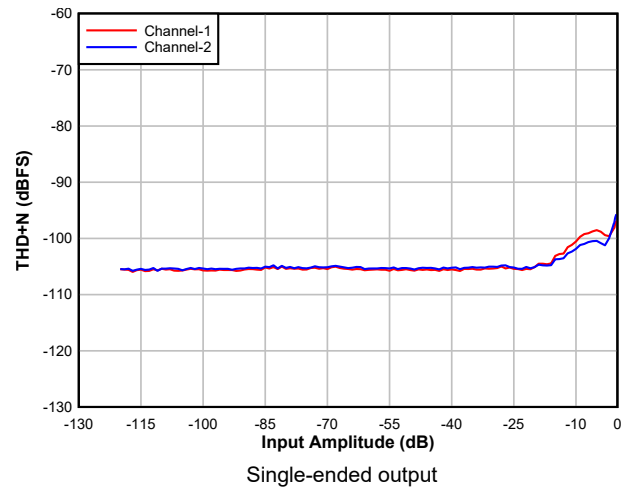


Figure 5-3. DAC THD+N Level vs Input

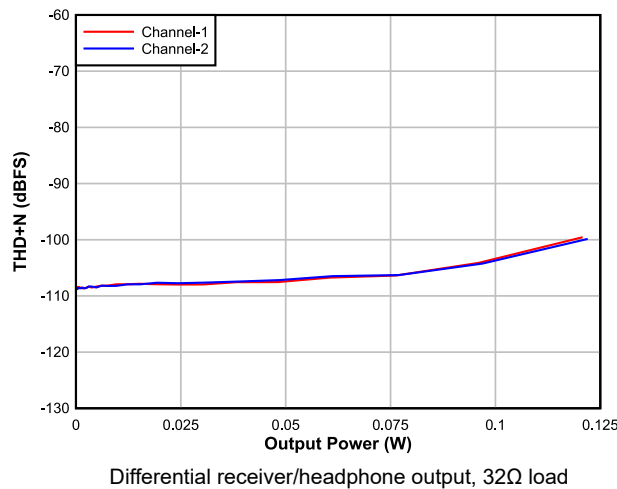


Figure 5-4. DAC THD+N Level vs Output Power

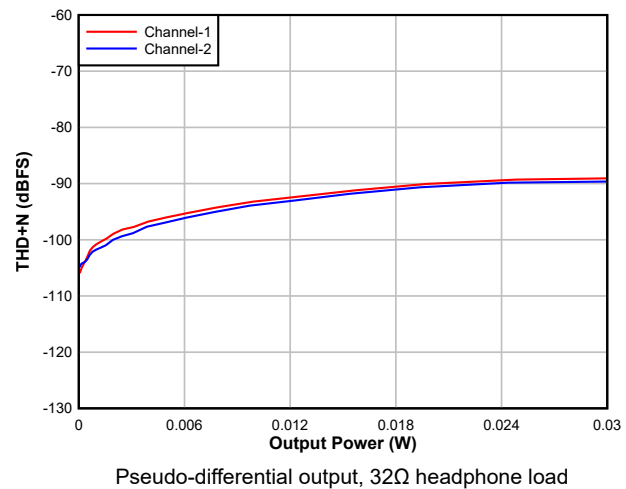
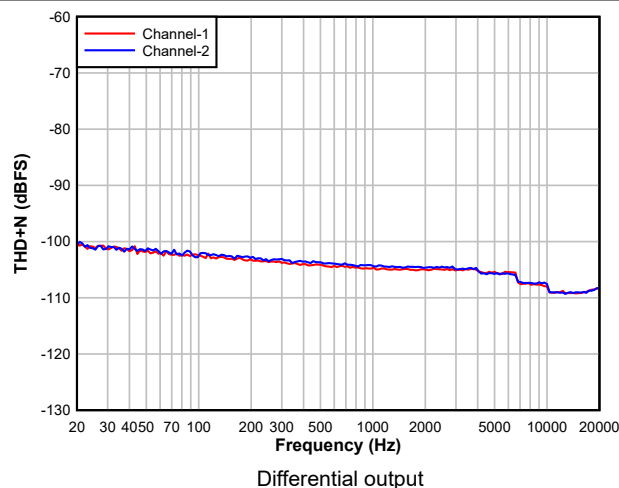
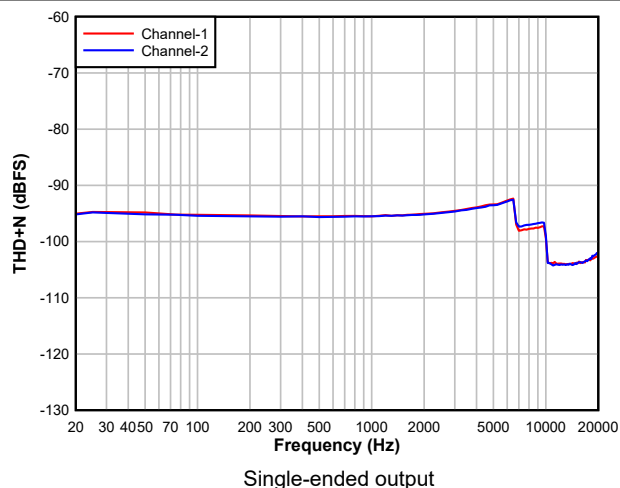
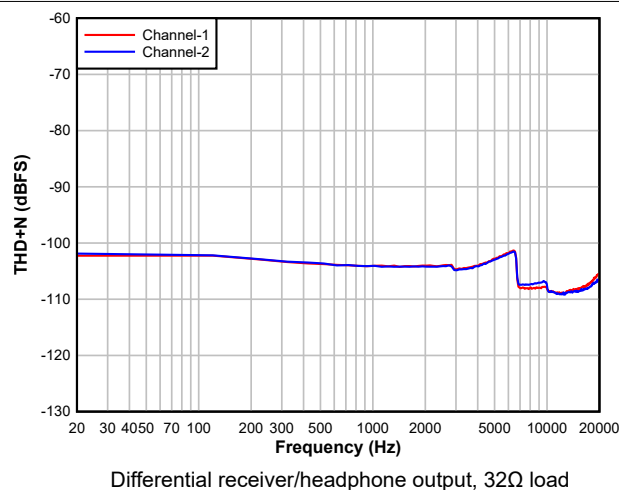
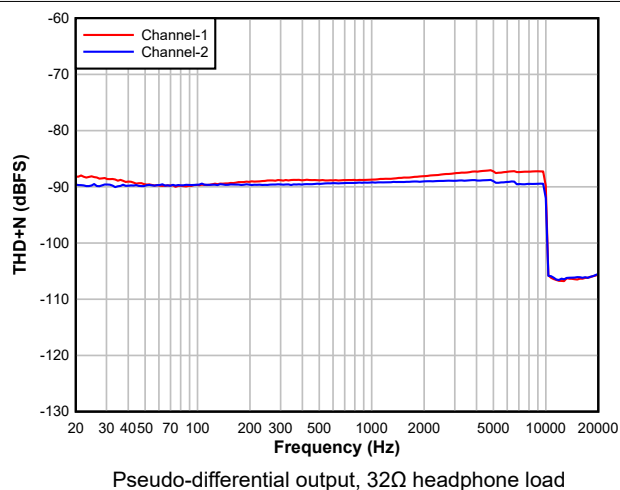
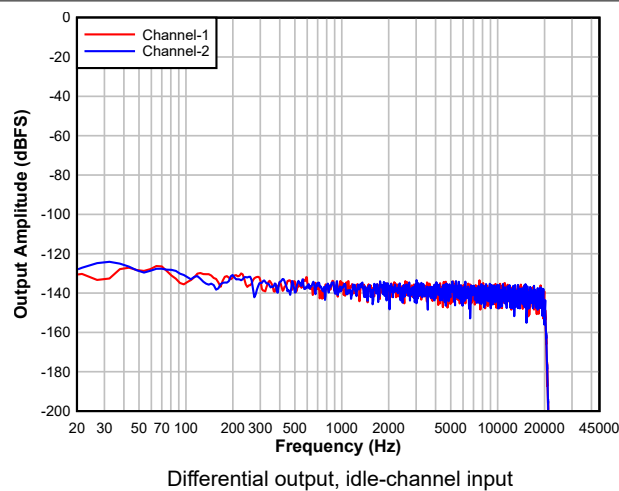
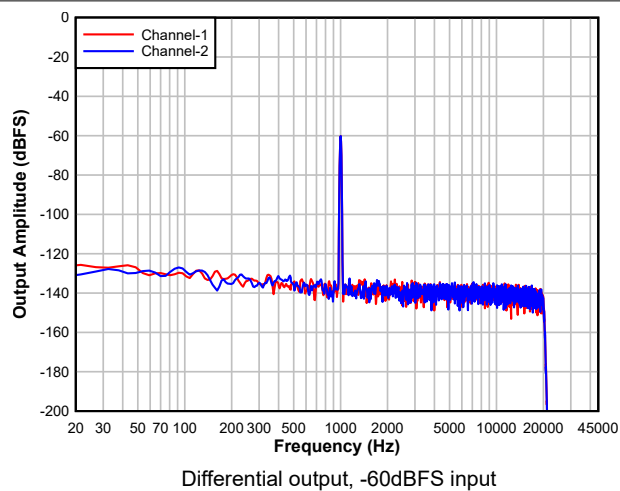
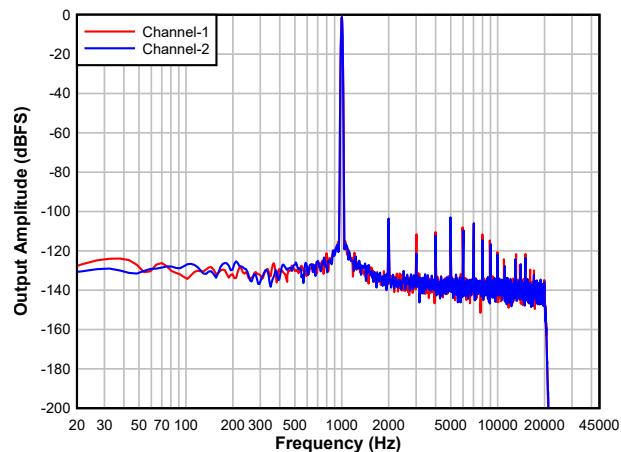


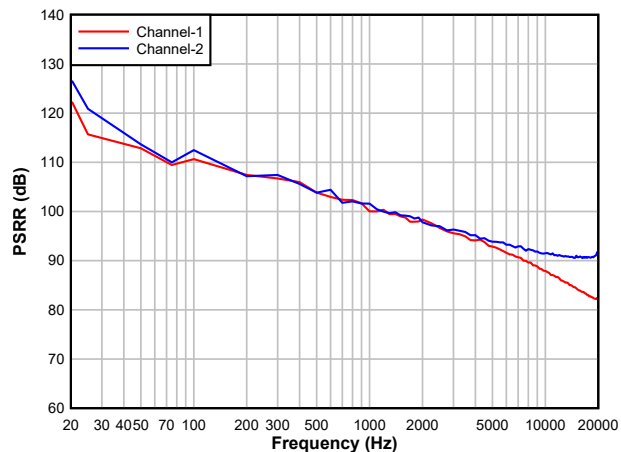
Figure 5-5. DAC THD+N Level vs Output Power


**図 5-6. DAC THD+N Level vs Frequency**

**図 5-7. DAC THD+N Level vs Frequency**

**図 5-8. DAC THD+N Level vs Frequency**

**図 5-9. DAC THD+N Level vs Frequency**

**図 5-10. DAC FFT**

**図 5-11. DAC FFT**



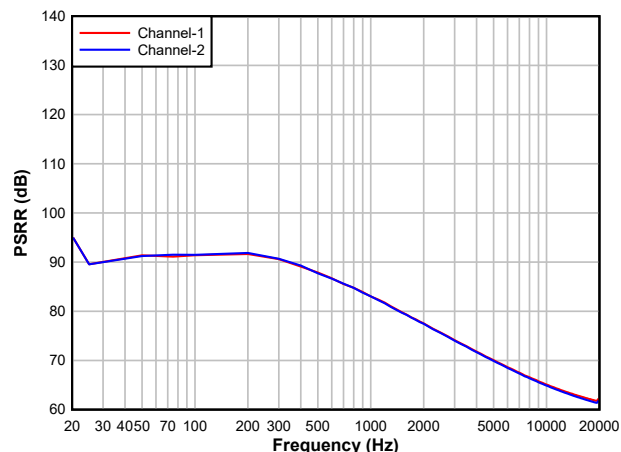
Differential output, -1dBFS input

図 5-12. DAC FFT



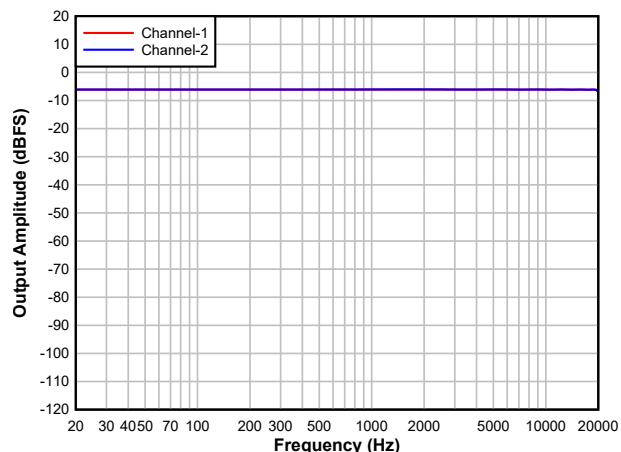
Differential output

図 5-13. DAC PSRR vs Frequency



Single-ended output

図 5-14. DAC PSRR vs Frequency



Differential output, -6dBFS input

図 5-15. DAC Frequency Response

## 6 Detailed Description

### 6.1 Overview

The TAD5142 is a high-performance, low-power, stereo audio digital-to-analog converter (DAC). This device is intended for broad market applications such as ruggedized communication equipment, IP network camera, professional audio and multimedia applications. This device integrates a host of features that reduce cost, board space, and power consumption in space-constrained system designs. Package, performance, and compatible configuration across an extended family makes this device well suited for scalable system designs.

The TAD5142 consists of the following features:

- 2-channel, multi-bit, high-performance delta-sigma ( $\Delta\Sigma$ ) DACs
- Pin or Hardware controlled device configurations
- Configurable single-ended, differential or pseudo-differential audio outputs
- Linear-phase or Low-latency digital interpolation filters
- Integrated low-jitter, phase-locked loop (PLL) supporting a wide range of system clocks
- Integrated digital and analog voltage regulators to support single-supply operation

### 6.2 Functional Block Diagram

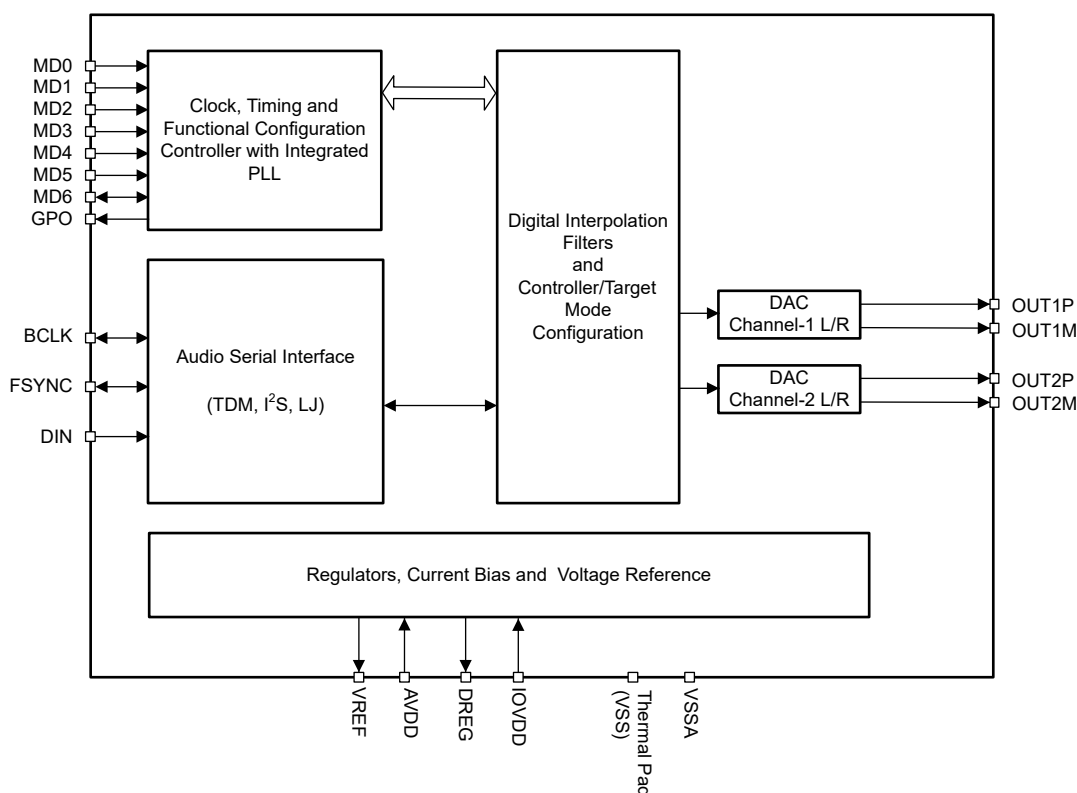


图 6-1. Functional Block Diagram

### 6.3 Feature Description

#### 6.3.1 Hardware Control

The device supports simple hardware-pin-controlled options to select a specific mode of operation and audio interface for a given system as summarized in 表 6-1. The MD1 to MD6 pins are connected to either logic low (VSS) or logic high (IOVDD), and the MD0 pin can be connected to AVDD or VSS through different pull-up or pull-down resistors.

**表 6-1. Pin Selectable Configurations Summary**

| PIN | TARGET MODE  | CONTROLLER MODE                         |
|-----|--|---|
| MD0 | Multi-level analog input for controller/target mode and I <sup>2</sup> S/TDM/LJ mode selection   |   |
| MD1 | AVDD supply, word length, and interpolation filter type selection  | Frame rate and BCLK frequency selection |
| MD2 |  |   |
| MD3 | Ground   | Controller clock input                  |
| MD4 | DAC output configuration selection (Differential Line-out/ Differential Receiver/Headphone/Single-ended Line-out/ Pseudo-differential Headphone) |   |
| MD5 |  |   |
| MD6 | TDM mode: Daisy chain output or I <sup>2</sup> S/LJ mode: Mono/Stereo selection  |   |

### 6.3.2 Audio Serial Interfaces

Digital audio data flows between the host processor and the TAD5142 on the digital audio serial interface (ASI), or audio bus. This bus can be operated in target or controller mode through pin control. The ASI supports TDM, I<sup>2</sup>S and Left-Justified bus protocols. The data is in MSB-first, two's-complement pulse code modulation (PCM) format, with pin-selectable word-length configuration.

The device supports an audio bus controller or target mode of operation using the hardware pin MD0. In target mode, FSYNC and BCLK work as input pins whereas in controller mode, FSYNC and BCLK work as output pins generated by the device. 表 6-2 shows the controller and target mode selection using the MD0 pin.

**表 6-2. Controller and Target Mode Selection**

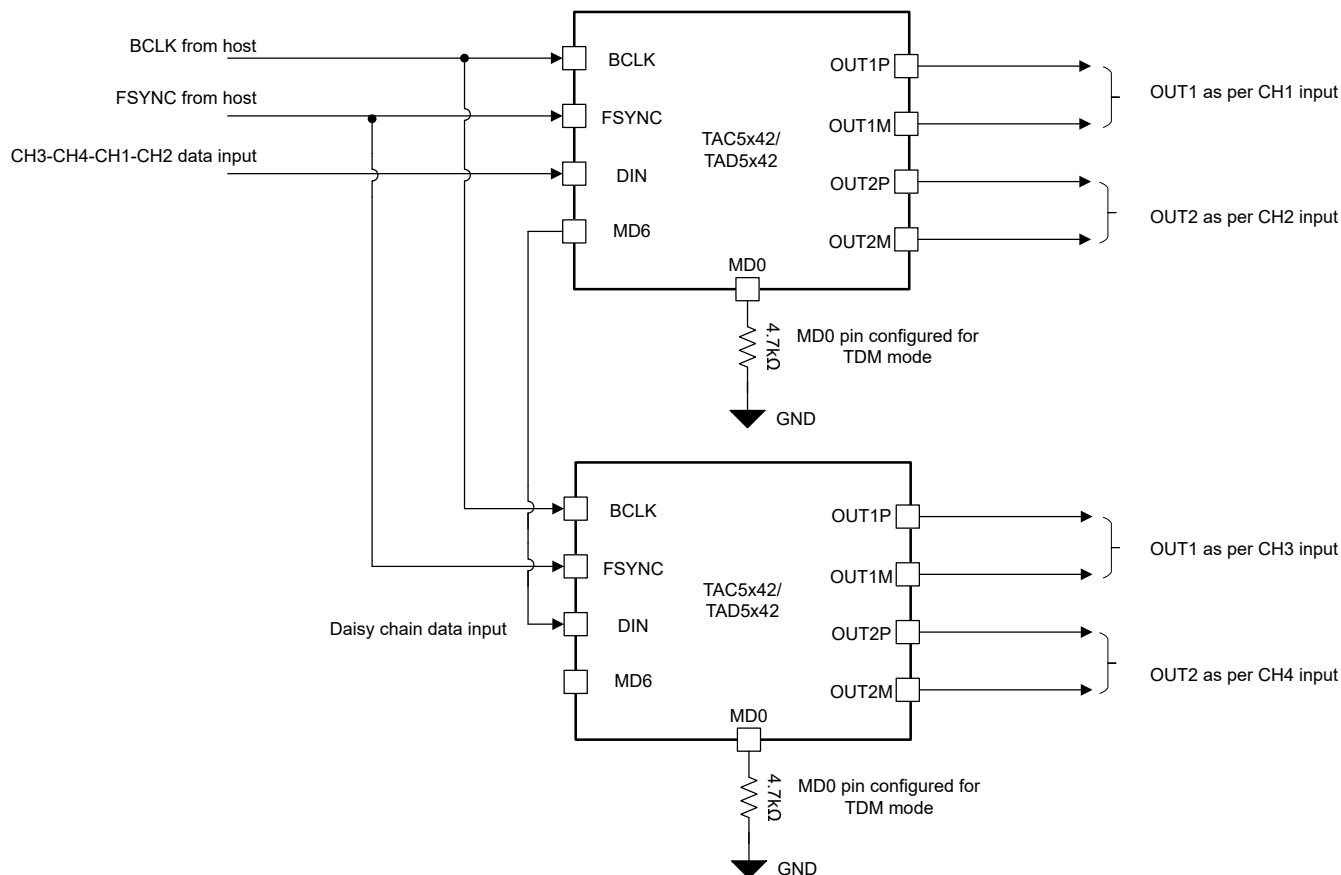
| MD0                            | CONTROLLER AND TARGET SELECTION  |
|--------------------------------|----------------------------------|
| Short to Ground                | Target I <sup>2</sup> S Mode     |
| Short to Ground with 4.7K Ohms | Target TDM Mode                  |
| Short to AVDD                  | Controller I <sup>2</sup> S Mode |
| Short to AVDD with 4.7K Ohms   | Controller TDM Mode              |
| Short to AVDD with 22K Ohms    | Target LJ Mode                   |

The word length for audio serial interface (ASI) in TAD5142 can be selected through MD1 and MD2 Pins in target mode of operation. The TAD5142 also supports 1.8V AVDD operation in target mode with 32-bit word length. 表 6-3 shows the configuration table for setting the word length, AVDD supply voltage and interpolation filter type applicable in Target Mode. In controller mode, AVDD supply mode is 3.3V, word length of 32-bits is supported, interpolation filter is configured in the linear-phase and the MD1 and MD2 Pins control the system clock configuration described in 表 6-8.

**表 6-3. Word Length, Supply Mode, and Interpolation Filter Selection**

| MD2  | MD1  | WORD LENGTH, SUPPLY MODE, AND INTERPOLATION FILTER SELECTION<br>(Valid for Target Mode only) |
|------|------|--|
| Low  | Low  | AVDD=3.3V, Word Length=32, Linear-phase Filter   |
| Low  | High | AVDD=1.8V, Word Length=32, Linear-phase Filter   |
| High | Low  | AVDD=3.3V, Word Length=24, Linear-phase Filter   |
| High | High | AVDD=3.3V, Word Length=32, Low-latency phase Filter  |

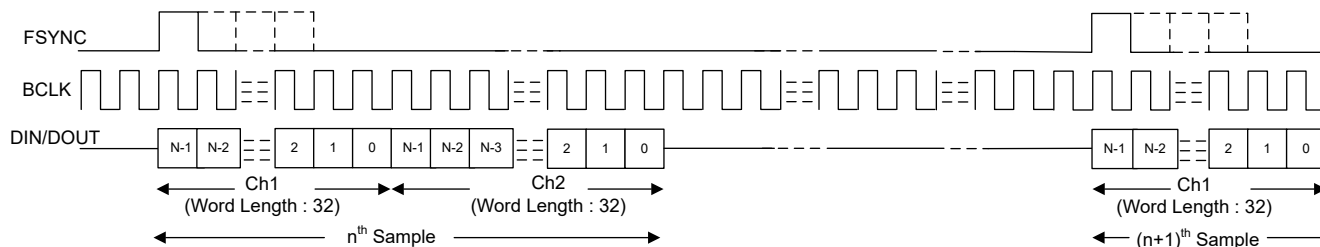
The TAD5142 also offers daisy chain option for TDM mode of operation. This option is auto enabled whenever device is selected to be in TDM Mode with MD0. MD6 Pin acts as a Daisy Chain output in this mode. In this case, for a TDM with N slots, the device plays the audio present on the last 2 slots, and the remaining slots are shifted to the right and sent on the MD6 pin, as shown in the block diagram in the 図 6-2.



**図 6-2. Daisy Chain in TDM Mode Block Diagram**

### 6.3.2.1 Time Division Multiplexed Audio (TDM) Interface

In TDM mode, also known as DSP mode, the rising edge of FSYNC starts the data transfer with the slot 0 data first. Immediately after the slot 0 data transmission, the remaining slot data are transmitted in order. FSYNC and each data bit is transmitted on the rising edge of BCLK and received on the falling edge of BCLK. 図 6-3 and 図 6-4 show the protocol timing for TDM operation with various configurations. DOUT refers to the Daisy Chain Output.



**図 6-3. TDM Mode Protocol Timing (MD0 shorted to ground with 4.7K Ohms) in Target Mode**



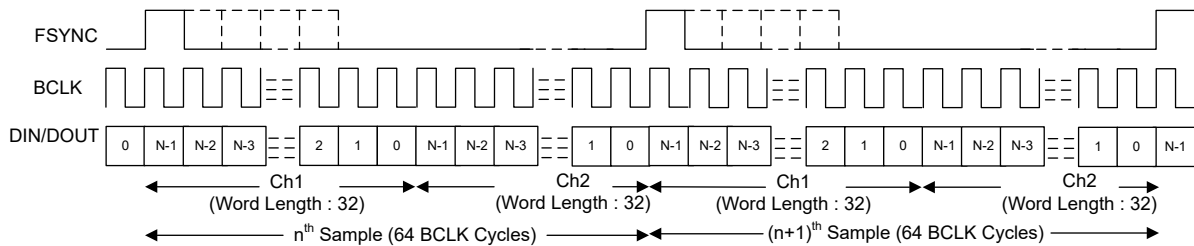


図 6-4. TDM Mode Protocol Timing (MD0 shorted to AVDD with 4.7K Ohms) in Controller Mode

For proper operation of the audio bus in TDM mode, the number of bit clocks per frame must be greater than or equal to the number of active input and output channels times the configured word length of the input and output channel data. The DOOUT pin is in a Hi-Z state for the extra unused bit clock cycles. The device supports FSYNC as a pulse with a 1-cycle-wide bit clock, but also supports multiples as well.

### 6.3.2.2 Inter IC Sound (I<sup>2</sup>S) Interface

The standard I<sup>2</sup>S protocol is defined for only two channels: left and right. In I<sup>2</sup>S mode, the MSB of the left slot 0 is received on the rising edge of BCLK in the second cycle after the *falling* edge of FSYNC. The MSB of the right slot 0 is received on the rising edge of BCLK in the second cycle after the *rising* edge of FSYNC. Each subsequent data bit is received on the rising edge of BCLK. In controller mode, FSYNC is transmitted on the falling edge of BCLK. 図 6-5 and 図 6-6 show the protocol timing for I<sup>2</sup>S operation in target and controller mode of operation.

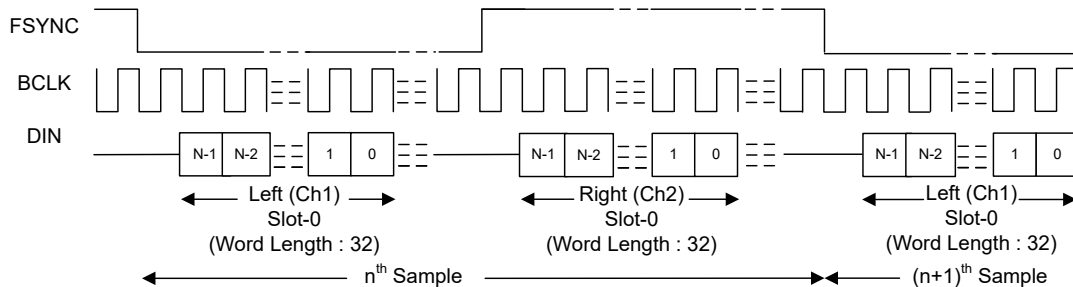


図 6-5. I<sup>2</sup>S Mode Protocol Timing (MD0 shorted to ground) in Target Mode

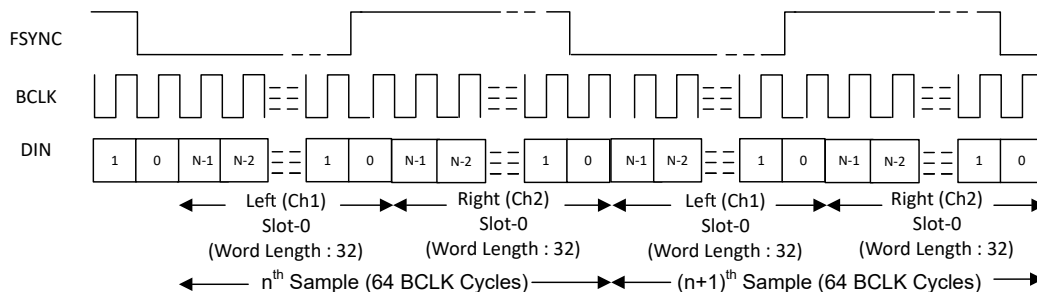


図 6-6. I<sup>2</sup>S Protocol Timing (MD0 shorted to AVDD) in Controller Mode

For proper operation of the audio bus in I<sup>2</sup>S mode, the number of bit clocks per frame must be greater than or equal to the number of active input channels (including left and right slots) times the configured word length of the input channel data.

### 6.3.2.3 Left-Justified (LJ) Interface

The standard LJ protocol is defined for only two channels: left and right. In LJ mode, the MSB of the left slot 0 is received in the same BCLK cycle after the *rising* edge of FSYNC. Each subsequent data bit is received on the

rising edge of BCLK. The MSB of the right slot 0 is received in the same BCLK cycle after the *falling* edge of FSYNC. 図 6-7 illustrates the protocol timing for LJ operation in target mode of cooperation.

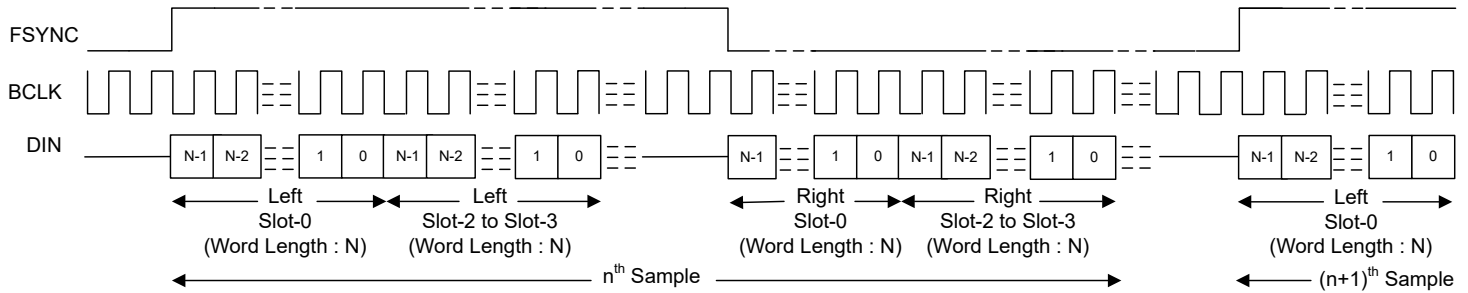


図 6-7. LJ Mode Standard Protocol Timing (MD0 shorted to AVDD with 22K Ohms) in Target Mode

For proper operation of the audio bus in LJ mode, the number of bit clocks per frame must be greater than or equal to the number of active input channels (including left and right slots) times the configured word length of the input channel data.

### 6.3.3 Phase-Locked Loop (PLL) and Clock Generation

The device uses an integrated, low-jitter, phase-locked loop (PLL) to generate internal clocks required for the DAC modulators and digital filter engine, as well as other control blocks.

In target mode of operation, the device supports the various output data sample rates (of the FSYNC signal frequency) and the BCLK to FSYNC ratio to configure all clock dividers, including the PLL configuration, internally without host programming. 表 6-4 to 表 6-7 list the supported FSYNC and BCLK frequencies depending on IOVDD Supply.

**表 6-4. Supported FSYNC (Multiples or Submultiples of 48 kHz) and BCLK Frequencies (IOVDD - 3.3V Operation)**

| BCLK TO<br>FSYNC RATIO | BCLK (MHz)       |                   |                   |                   |                   |                   |                    |
|------------------------|------------------|-------------------|-------------------|-------------------|-------------------|-------------------|--------------------|
|                        | FSYNC<br>(8 kHz) | FSYNC<br>(16 kHz) | FSYNC<br>(24 kHz) | FSYNC<br>(32 kHz) | FSYNC<br>(48 kHz) | FSYNC<br>(96 kHz) | FSYNC<br>(192 kHz) |
| 16                     | Reserved         | 0.256             | 0.384             | 0.512             | 0.768             | 1.536             | 3.072              |
| 24                     | Reserved         | 0.384             | 0.576             | 0.768             | 1.152             | 2.304             | 4.608              |
| 32                     | 0.256            | 0.512             | 0.768             | 1.024             | 1.536             | 3.072             | 6.144              |
| 48                     | 0.384            | 0.768             | 1.152             | 1.536             | 2.304             | 4.608             | 9.216              |
| 64                     | 0.512            | 1.024             | 1.536             | 2.048             | 3.072             | 6.144             | 12.288             |
| 96                     | 0.768            | 1.536             | 2.304             | 3.072             | 4.608             | 9.216             | 18.432             |
| 128                    | 1.024            | 2.048             | 3.072             | 4.096             | 6.144             | 12.288            | 24.576             |
| 192                    | 1.536            | 3.072             | 4.608             | 6.144             | 9.216             | 18.432            | Reserved           |
| 256                    | 2.048            | 4.096             | 6.144             | 8.192             | 12.288            | 24.576            | Reserved           |
| 384                    | 3.072            | 6.144             | 9.216             | 12.288            | 18.432            | Reserved          | Reserved           |
| 512                    | 4.096            | 8.192             | 12.288            | 16.384            | 24.576            | Reserved          | Reserved           |

**表 6-5. Supported FSYNC (Multiples or Submultiples of 44.1 kHz) and BCLK Frequencies (IOVDD - 3.3V Operation)**

| BCLK TO<br>FSYNC RATIO | BCLK (MHz)          |                     |                      |                     |                     |                     |                      |
|------------------------|---------------------|---------------------|----------------------|---------------------|---------------------|---------------------|----------------------|
|                        | FSYNC<br>(7.35 kHz) | FSYNC<br>(14.7 kHz) | FSYNC<br>(22.05 kHz) | FSYNC<br>(29.4 kHz) | FSYNC<br>(44.1 kHz) | FSYNC<br>(88.2 kHz) | FSYNC<br>(176.4 kHz) |
| 16                     | Reserved            | Reserved            | 0.3528               | 0.4704              | 0.7056              | 1.4112              | 2.8224               |
| 24                     | Reserved            | 0.3528              | 0.5292               | 0.7056              | 1.0584              | 2.1168              | 4.2336               |
| 32                     | Reserved            | 0.4704              | 0.7056               | 0.9408              | 1.4112              | 2.8224              | 5.6448               |
| 48                     | 0.3528              | 0.7056              | 1.0584               | 1.4112              | 2.1168              | 4.2336              | 8.4672               |
| 64                     | 0.4704              | 0.9408              | 1.4112               | 1.8816              | 2.8224              | 5.6448              | 11.2896              |
| 96                     | 0.7056              | 1.4112              | 2.1168               | 2.8224              | 4.2336              | 8.4672              | 16.9344              |
| 128                    | 0.9408              | 1.8816              | 2.8224               | 3.7632              | 5.6448              | 11.2896             | 22.5792              |
| 192                    | 1.4112              | 2.8224              | 4.2336               | 5.6448              | 8.4672              | 16.9344             | Reserved             |
| 256                    | 1.8816              | 3.7632              | 5.6448               | 7.5264              | 11.2896             | 22.5792             | Reserved             |
| 384                    | 2.8224              | 5.6448              | 8.4672               | 11.2896             | 16.9344             | Reserved            | Reserved             |
| 512                    | 3.7632              | 7.5264              | 11.2896              | 15.0528             | 22.5792             | Reserved            | Reserved             |

**表 6-6. Supported FSYNC (Multiples or Submultiples of 48 kHz) and BCLK Frequencies (IOVDD - 1.8V Operation)**

| BCLK TO<br>FSYNC RATIO | BCLK (MHz)       |                   |                   |                   |                   |                   |                    |
|------------------------|------------------|-------------------|-------------------|-------------------|-------------------|-------------------|--------------------|
|                        | FSYNC<br>(8 kHz) | FSYNC<br>(16 kHz) | FSYNC<br>(24 kHz) | FSYNC<br>(32 kHz) | FSYNC<br>(48 kHz) | FSYNC<br>(96 kHz) | FSYNC<br>(192 kHz) |
| 16                     | Reserved         | 0.256             | 0.384             | 0.512             | 0.768             | 1.536             | 3.072              |
| 24                     | Reserved         | 0.384             | 0.576             | 0.768             | 1.152             | 2.304             | 4.608              |

**表 6-6. Supported FSYNC (Multiples or Submultiples of 48 kHz) and BCLK Frequencies (IOVDD - 1.8V Operation) (続き)**

| BCLK TO<br>FSYNC RATIO | BCLK (MHz)       |                   |                   |                   |                   |                   |                    |
|------------------------|------------------|-------------------|-------------------|-------------------|-------------------|-------------------|--------------------|
|                        | FSYNC<br>(8 kHz) | FSYNC<br>(16 kHz) | FSYNC<br>(24 kHz) | FSYNC<br>(32 kHz) | FSYNC<br>(48 kHz) | FSYNC<br>(96 kHz) | FSYNC<br>(192 kHz) |
| 32                     | 0.256            | 0.512             | 0.768             | 1.024             | 1.536             | 3.072             | 6.144              |
| 48                     | 0.384            | 0.768             | 1.152             | 1.536             | 2.304             | 4.608             | 9.216              |
| 64                     | 0.512            | 1.024             | 1.536             | 2.048             | 3.072             | 6.144             | 12.288             |
| 96                     | 0.768            | 1.536             | 2.304             | 3.072             | 4.608             | 9.216             | Reserved           |
| 128                    | 1.024            | 2.048             | 3.072             | 4.096             | 6.144             | 12.288            | Reserved           |
| 192                    | 1.536            | 3.072             | 4.608             | 6.144             | 9.216             | Reserved          | <b>Reserved</b>    |
| 256                    | 2.048            | 4.096             | 6.144             | 8.192             | 12.288            | Reserved          | <b>Reserved</b>    |
| 384                    | 3.072            | 6.144             | 9.216             | 12.288            | Reserved          | <b>Reserved</b>   | <b>Reserved</b>    |
| 512                    | 4.096            | 8.192             | 12.288            | Reserved          | Reserved          | <b>Reserved</b>   | <b>Reserved</b>    |

**表 6-7. Supported FSYNC (Multiples or Submultiples of 44.1 kHz) and BCLK Frequencies (IOVDD - 1.8V Operation)**

| BCLK TO<br>FSYNC RATIO | BCLK (MHz)          |                     |                      |                     |                     |                     |                      |
|------------------------|---------------------|---------------------|----------------------|---------------------|---------------------|---------------------|----------------------|
|                        | FSYNC<br>(7.35 kHz) | FSYNC<br>(14.7 kHz) | FSYNC<br>(22.05 kHz) | FSYNC<br>(29.4 kHz) | FSYNC<br>(44.1 kHz) | FSYNC<br>(88.2 kHz) | FSYNC<br>(176.4 kHz) |
| 16                     | <b>Reserved</b>     | <b>Reserved</b>     | 0.3528               | 0.4704              | 0.7056              | 1.4112              | 2.8224               |
| 24                     | <b>Reserved</b>     | 0.3528              | 0.5292               | 0.7056              | 1.0584              | 2.1168              | 4.2336               |
| 32                     | <b>Reserved</b>     | 0.4704              | 0.7056               | 0.9408              | 1.4112              | 2.8224              | 5.6448               |
| 48                     | 0.3528              | 0.7056              | 1.0584               | 1.4112              | 2.1168              | 4.2336              | 8.4672               |
| 64                     | 0.4704              | 0.9408              | 1.4112               | 1.8816              | 2.8224              | 5.6448              | 11.2896              |
| 96                     | 0.7056              | 1.4112              | 2.1168               | 2.8224              | 4.2336              | 8.4672              | Reserved             |
| 128                    | 0.9408              | 1.8816              | 2.8224               | 3.7632              | 5.6448              | 11.2896             | Reserved             |
| 192                    | 1.4112              | 2.8224              | 4.2336               | 5.6448              | 8.4672              | Reserved            | <b>Reserved</b>      |
| 256                    | 1.8816              | 3.7632              | 5.6448               | 7.5264              | 11.2896             | Reserved            | <b>Reserved</b>      |
| 384                    | 2.8224              | 5.6448              | 8.4672               | 11.2896             | Reserved            | <b>Reserved</b>     | <b>Reserved</b>      |
| 512                    | 3.7632              | 7.5264              | 11.2896              | Reserved            | Reserved            | <b>Reserved</b>     | <b>Reserved</b>      |

In the controller mode of operation, the device uses the MD3 pin, as the system clock, CCLK for the reference input clock source. In target mode of operation, the MD3 pin should be grounded.

The device provides flexibility in FSYNC selection with a supported system clock frequency option of either  $256 \times f_S$  or  $128 \times f_S$  or a fixed 48/44.1KSPS or 96/88.2KSPS as configured using the MD1 and MD2 pins.

The table 表 6-8 shows the FSYNC and BCLK selection for the controller mode using the MD1 and MD2 pins. In controller mode of operation, AVDD = 3.3V and Word-Length = 32.

**表 6-8. System Clock Selection for the Controller Mode**

| MD2  | MD1  | SYSTEM CLOCK SELECTION (Valid for Controller Mode only) |                        |   |
|------|------|---|------------------------|---|
|      |      | FSYNC   | I <sup>2</sup> S Mode  | TDM Mode  |
| Low  | Low  | FSYNC = CCLK/256  | BCLK = $64 \times f_S$ | For FSYNC $\leq 48$ KSPS, BCLK = $256 \times f_S$ , for 48KSPS < FSYNC $\leq 96$ KSPS, BCLK = $128 \times f_S$ , and for FSYNC > 96KSPS, BCLK = $64 \times f_S$ |
| Low  | High | FSYNC = CCLK/128  |                        |   |
| High | Low  | FSYNC = 96/88.2KSPS                                     |                        | BCLK = $128 \times f_S$   |
| High | High | FSYNC = 48/44.1KSPS                                     |                        | BCLK = $256 \times f_S$   |

See 表 6-2 for the MD1 and MD2 pin function in the target mode of operation.

### 6.3.4 Analog Output Configurations

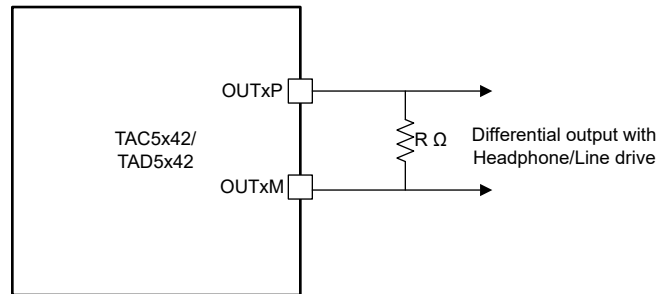
The device supports playback of two channels using the high-performance stereo DAC. The device consists of two pairs of analog output pins (OUTxP and OUTxM) which can be configured in single-ended or differential input mode by setting MD4 and MD5 pins. The input source for these channels is from TDM/I<sup>2</sup>S/LJ interface.

表 6-9 shows the analog output configuration modes available with MD4 and MD5 pins.

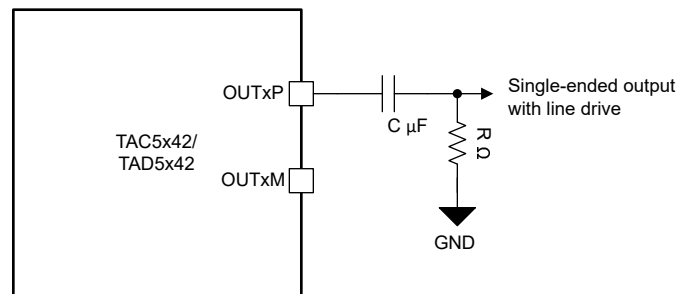
**表 6-9. Analog Output Configurations**

| MD5  | MD4  | ANALOG OUTPUT CONFIGURATION   |
|------|------|---|
| Low  | Low  | Differential Output; Line-out only  |
| Low  | High | Differential Output; Receiver/Headphone load or Line-out                        |
| High | Low  | Single-ended output; Line-out only  |
| High | High | Pseudo differential output with external common-mode sense; Headphone load only |

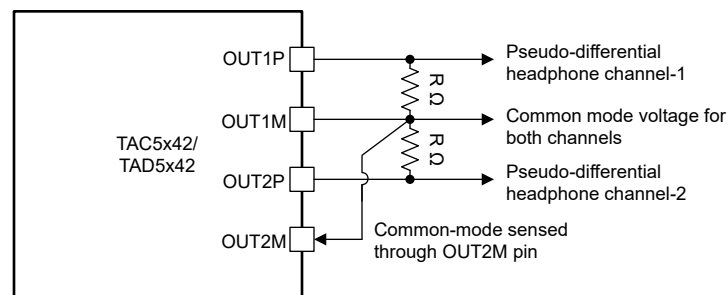
図 6-8 to 図 6-10 show the typical configuration diagrams for the various output modes.



**図 6-8. Typical Application Diagram for Differential Output Connection**



**図 6-9. Typical Application Diagram for Single-ended Output Connection**



**図 6-10. Typical Application Diagram for Pseudo-differential Output Connection with External Common-Mode Sense**

The device also supports channel select configurations to enable mono or stereo output in I<sup>2</sup>S and LJ Modes. This can be configured by setting MD6 pin. 表 6-10 shows the control for this feature with MD6 configuration. DAC Channel-2 is disabled when MD6 pin is set to High. In TDM mode, MD6 pin function is as described in 図 6-2.

**表 6-10. Output Channel Select configuration in I<sup>2</sup>S and LJ Modes**

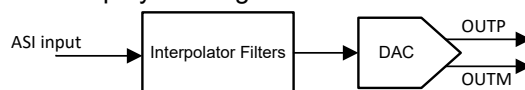
| MD6  | ANALOG OUTPUT CONFIGURATION                        |
|------|--|
| Low  | Stereo DAC   |
| High | Mono 1-Channel DAC (OUT1x enabled, OUT2x disabled) |

### 6.3.5 Reference Voltage

All audio data converters require a DC reference voltage. The TAD5142 achieves low-noise performance by internally generating a low-noise reference voltage. This reference voltage is generated using a band-gap circuit with high PSRR performance. This audio converter reference voltage must be filtered externally using a minimum 1μF capacitor connected from the VREF pin to the device ground (VSS). The value of this reference voltage, VREF, is set to 2.75V, which in turn supports a 2V<sub>RMS</sub> differential full-scale output to the device. The required minimum AVDD voltage for this VREF voltage is 3V. When the device is configured for 1.8V AVDD supply voltage, the voltage on the VREF pin is 1.375V, which supports a 1V<sub>RMS</sub> differential full-scale output to the device. Do not connect any external load to the VREF pin.

### 6.3.6 DAC Signal-Chain

図 6-11 shows the key components of the playback signal chain.



**図 6-11. DAC Signal-Chain Processing Flowchart**

The DAC signal chain offers a highly flexible low-noise playback path for low-noise and high-fidelity audio applications. This low-noise and low-distortion, multi-bit, delta-sigma DAC enables the TAD5142 to achieve a high dynamic range in very low power. Moreover, the DAC architecture has inherent anti-alias filtering with a high rejection of out-of-band frequency noise around multiple modulator frequency components. Therefore, the device prevents noise from aliasing into the audio band. The TAD5142 also integrates, high-performance multi-stage digital interpolation filter sharply cuts off any out-of-band frequency noise with high stop-band attenuation.

### 6.3.6.1 Digital Interpolation Filters

The device playback channel includes a high dynamic range, built-in digital interpolation filter to process the input data stream to generate digital data stream for multibit delta-sigma ( $\Delta\Sigma$ ) modulator. The interpolation filters in the device can be selected to linear phase or low-latency filters based on the state of the MD2 and MD1 pins according to 表 6-3. This makes them suitable for a wide variety of audio applications. Following section describes the filter response for different samples rates.

#### 6.3.6.1.1 Linear-phase filters

The linear-phase interpolation filters are the default filters set by the device and can be used for all applications that require a perfect linear phase with zero-phase deviation within the pass-band specification of the filter. The filter performance specifications and various plots for all supported output sampling rates are listed in this section.

##### 6.3.6.1.1.1 Sampling Rate: 8kHz or 7.35kHz

図 6-12 and 図 6-13 respectively show the magnitude response and the pass-band ripple for this interpolation filter with a sampling rate of 8kHz or 7.35kHz, and 表 6-11 lists its specifications.

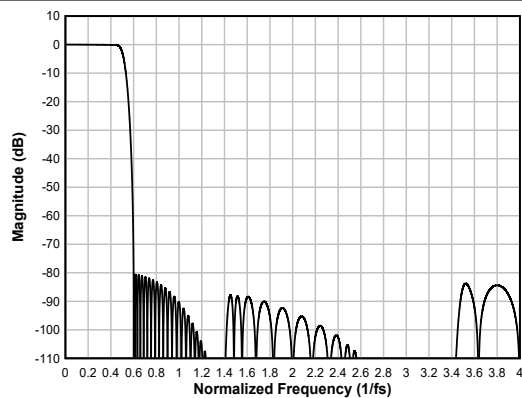


図 6-12. Linear-phase Interpolation Filter Magnitude Response

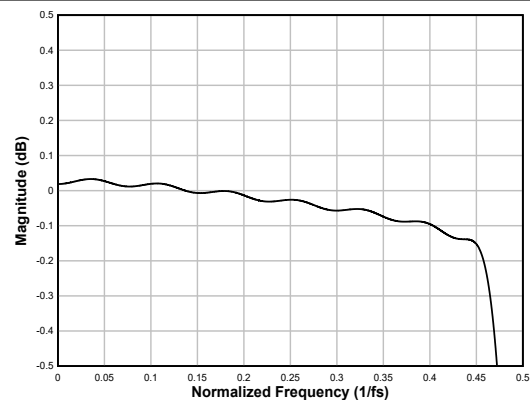


図 6-13. Linear-phase Interpolation Filter Pass-Band Ripple

表 6-11. Linear-phase Interpolation Filter Specifications

| PARAMETER              | TEST CONDITIONS   | MIN   | TYP | MAX  | UNIT    |
|------------------------|---|-------|-----|------|---------|
| Pass-band ripple       | Frequency range is 0 to $0.455 \times f_s$              | -0.17 |     | 0.03 | dB      |
| Stop-band attenuation  | Frequency range is $0.6 \times f_s$ to $4 \times f_s$   | 80.4  |     |      | dB      |
|                        | Frequency range is $4 \times f_s$ to $7.431 \times f_s$ | 86.9  |     |      |         |
| Group delay or latency | Frequency range is 0 to $0.455 \times f_s$              |       | 16  |      | $1/f_s$ |



### 6.3.6.1.1.2 Sampling Rate: 16kHz or 14.7kHz

図 6-14 and 図 6-15 respectively show the magnitude response and the pass-band ripple for this interpolation filter with a sampling rate of 16kHz or 14.7kHz, and 表 6-12 lists its specifications.

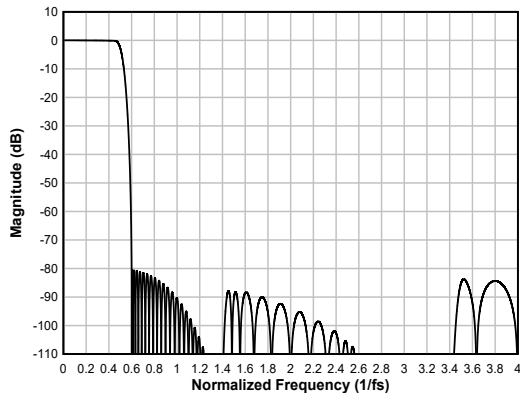


図 6-14. Linear-phase Interpolation Filter Magnitude Response

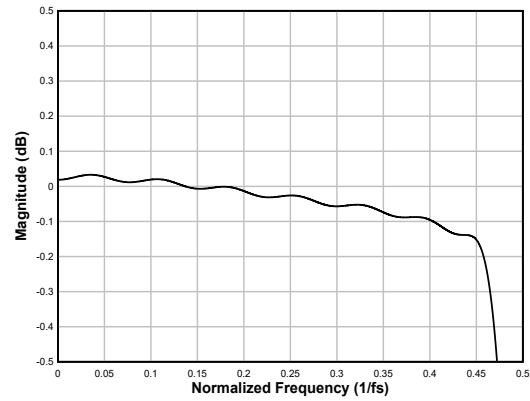


図 6-15. Linear-phase Interpolation Filter Pass-Band Ripple

表 6-12. Linear-phase Interpolation Filter Specifications

| PARAMETER              | TEST CONDITIONS   | MIN   | TYP | MAX  | UNIT    |
|------------------------|---|-------|-----|------|---------|
| Pass-band ripple       | Frequency range is 0 to $0.455 \times f_s$              | -0.17 |     | 0.03 | dB      |
| Stop-band attenuation  | Frequency range is $0.6 \times f_s$ to $4 \times f_s$   | 80.4  |     |      | dB      |
|                        | Frequency range is $4 \times f_s$ to $7.431 \times f_s$ | 86.9  |     |      |         |
| Group delay or latency | Frequency range is 0 to $0.455 \times f_s$              |       | 16  |      | $1/f_s$ |

### 6.3.6.1.1.3 Sampling Rate: 24kHz or 22.05kHz

図 6-16 and 図 6-17 respectively show the magnitude response and the pass-band ripple for this interpolation filter with a sampling rate of 24kHz or 22.05kHz, and 表 6-13 lists its specifications.

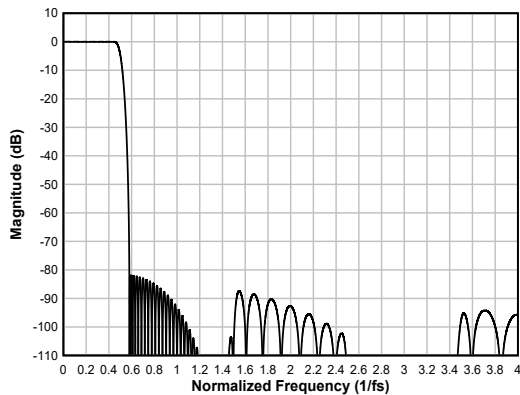


図 6-16. Linear-phase Interpolation Filter Magnitude Response

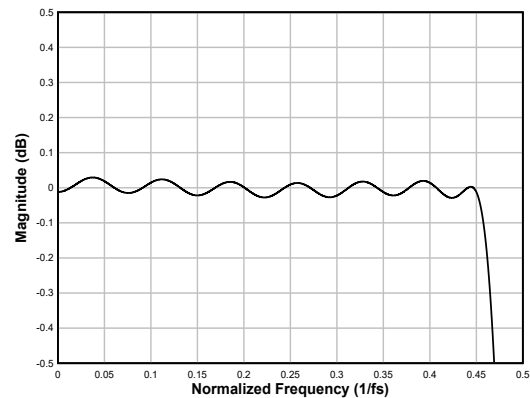


図 6-17. Linear-phase Interpolation Filter Pass-Band Ripple

表 6-13. Linear-phase Interpolation Filter Specifications

| PARAMETER             | TEST CONDITIONS  | MIN   | TYP | MAX  | UNIT |
|-----------------------|--|-------|-----|------|------|
| Pass-band ripple      | Frequency range is 0 to $0.455 \times f_s$             | -0.05 |     | 0.03 | dB   |
| Stop-band attenuation | Frequency range is $0.58 \times f_s$ to $4 \times f_s$ | 81.9  |     |      | dB   |
|                       | Frequency range is $4 \times f_s$ to $8 \times f_s$    | 87.7  |     |      |      |

表 6-13. Linear-phase Interpolation Filter Specifications (続き)

| PARAMETER              | TEST CONDITIONS                            | MIN | TYP  | MAX | UNIT    |
|------------------------|--|-----|------|-----|---------|
| Group delay or latency | Frequency range is 0 to $0.455 \times f_S$ |     | 17.6 |     | $1/f_S$ |

## 6.3.6.1.1.4 Sampling Rate: 32kHz or 29.4kHz

図 6-18 and 図 6-19 respectively show the magnitude response and the pass-band ripple for this interpolation filter with a sampling rate of 32kHz or 29.4kHz, and 表 6-14 lists its specifications.

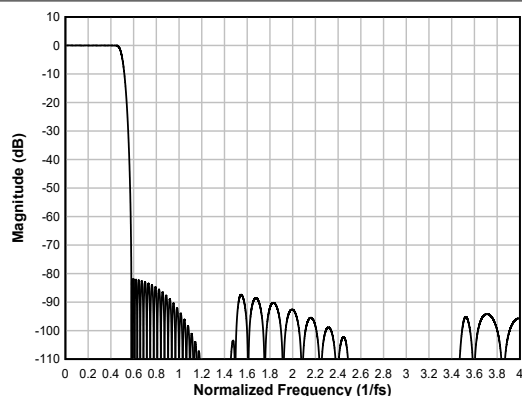


図 6-18. Linear-phase Interpolation Filter Magnitude Response

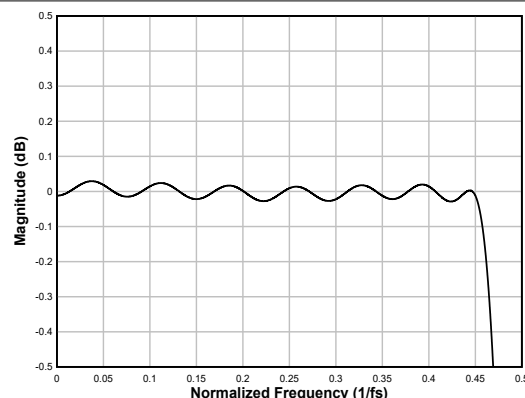


図 6-19. Linear-phase Interpolation Filter Pass-Band Ripple

表 6-14. Linear-phase Interpolation Filter Specifications

| PARAMETER              | TEST CONDITIONS  | MIN   | TYP  | MAX  | UNIT    |
|------------------------|--|-------|------|------|---------|
| Pass-band ripple       | Frequency range is 0 to $0.455 \times f_S$             | -0.05 |      | 0.03 | dB      |
| Stop-band attenuation  | Frequency range is $0.58 \times f_S$ to $4 \times f_S$ | 81.9  |      |      | dB      |
|                        | Frequency range is $4 \times f_S$ to $8 \times f_S$    | 87.6  |      |      |         |
| Group delay or latency | Frequency range is 0 to $0.455 \times f_S$             |       | 17.6 |      | $1/f_S$ |

## 6.3.6.1.1.5 Sampling Rate: 48kHz or 44.1kHz

図 6-20 and 図 6-21 respectively show the magnitude response and the pass-band ripple for this interpolation filter with a sampling rate of 48kHz or 44.1kHz, and 表 6-15 lists its specifications.

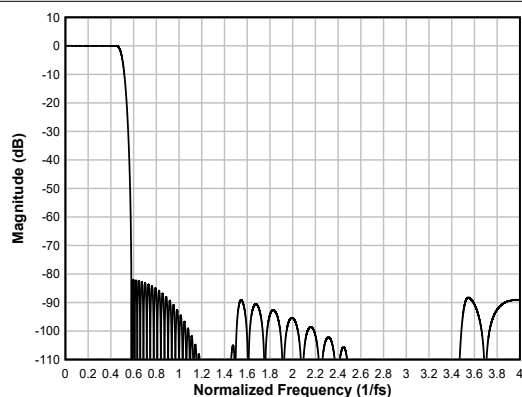


図 6-20. Linear-phase Interpolation Filter Magnitude Response

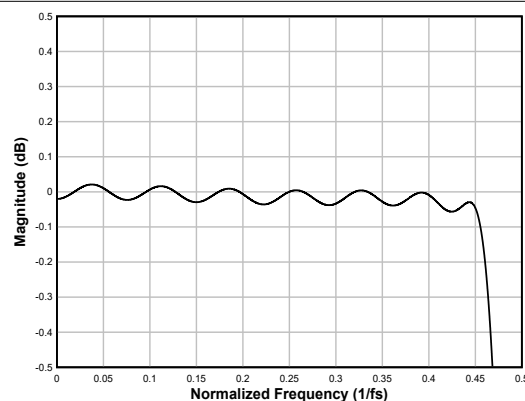


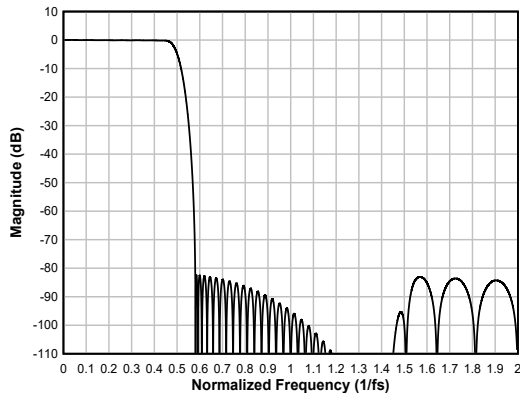
図 6-21. Linear-phase Interpolation Filter Pass-Band Ripple

**表 6-15. Linear-phase Interpolation Filter Specifications**

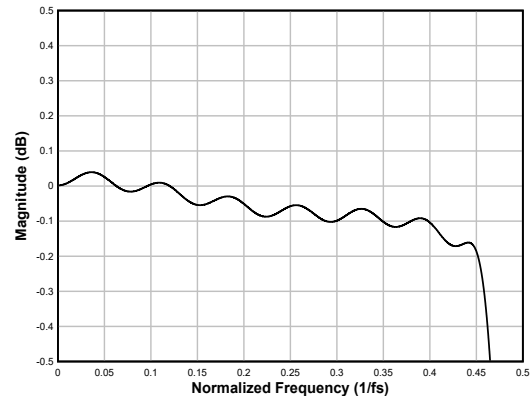
| PARAMETER              | TEST CONDITIONS   | MIN   | TYP  | MAX  | UNIT    |
|------------------------|---|-------|------|------|---------|
| Pass-band ripple       | Frequency range is 0 to $0.455 \times f_S$              | –0.09 |      | 0.02 | dB      |
| Stop-band attenuation  | Frequency range is $0.58 \times f_S$ to $4 \times f_S$  | 82    |      |      | dB      |
|                        | Frequency range is $4 \times f_S$ to $7.423 \times f_S$ | 89.1  |      |      |         |
| Group delay or latency | Frequency range is 0 to $0.455 \times f_S$              |       | 17.3 |      | $1/f_S$ |

**6.3.6.1.1.6 Sampling Rate: 96kHz or 88.2kHz**

図 6-22 and 図 6-23 respectively show the magnitude response and the pass-band ripple for this interpolation filter with a sampling rate of 96kHz or 88.2kHz, and 表 6-16 lists its specifications.



**図 6-22. Linear-phase Interpolation Filter Magnitude Response**



**図 6-23. Linear-phase Interpolation Filter Pass-Band Ripple**

**表 6-16. Linear-phase Interpolation Filter Specifications**

| PARAMETER              | TEST CONDITIONS   | MIN   | TYP  | MAX  | UNIT    |
|------------------------|---|-------|------|------|---------|
| Pass-band ripple       | Frequency range is 0 to $0.455 \times f_S$              | –0.23 |      | 0.04 | dB      |
| Stop-band attenuation  | Frequency range is $0.58 \times f_S$ to $2 \times f_S$  | 82.4  |      |      | dB      |
|                        | Frequency range is $2 \times f_S$ to $3.422 \times f_S$ | 85.1  |      |      |         |
| Group delay or latency | Frequency range is 0 to $0.455 \times f_S$              |       | 16.7 |      | $1/f_S$ |

**6.3.6.1.1.7 Sampling Rate: 192kHz or 176.4kHz**

図 6-24 and 図 6-25 respectively show the magnitude response and the pass-band ripple for this interpolation filter with a sampling rate of 192kHz or 176.4kHz, and 表 6-17 lists its specifications.

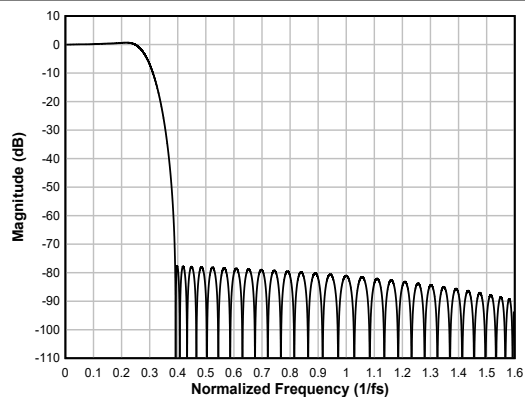


図 6-24. Linear-phase Interpolation Filter Magnitude Response

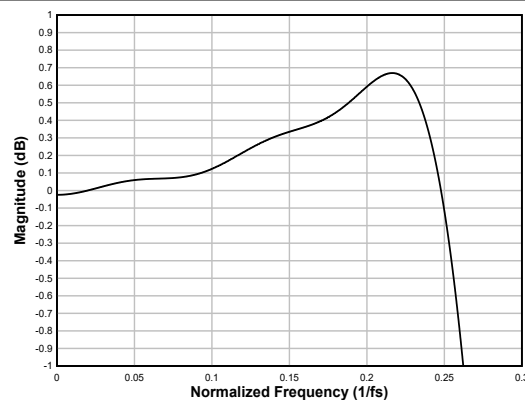


図 6-25. Linear-phase Interpolation Filter Pass-Band Ripple

表 6-17. Linear-phase Interpolation Filter Specifications

| PARAMETER              | TEST CONDITIONS   | MIN   | TYP  | MAX  | UNIT    |
|------------------------|---|-------|------|------|---------|
| Pass-band ripple       | Frequency range is 0 to $0.258 \times f_s$              | -0.67 |      | 0.67 | dB      |
| Stop-band attenuation  | Frequency range is $0.391 \times f_s$ to $1 \times f_s$ | 77.7  |      |      | dB      |
|                        | Frequency range is $1 \times f_s$ to $1.612 \times f_s$ | 81.1  |      |      |         |
| Group delay or latency | Frequency range is 0 to $0.258 \times f_s$              |       | 10.7 |      | $1/f_s$ |

### 6.3.6.1.2 Low-latency Filters

For applications where low latency with minimal phase deviation (within the audio band) is critical, the low-latency interpolation filters on the TAD5142 can be used. The device supports these filters with a group delay of approximately seven samples with an almost linear phase response within the  $0.376 \times f_s$  frequency band. This section provides the filter performance specifications and various plots for all supported output sampling rates for the low-latency filters.

#### 6.3.6.1.2.1 Sampling Rate: 24kHz or 22.05kHz

図 6-26 shows the magnitude response and 図 6-27 shows the pass-band ripple and phase deviation for this interpolation filter with a sampling rate of 24kHz or 22.05kHz. 表 6-18 lists its specifications.

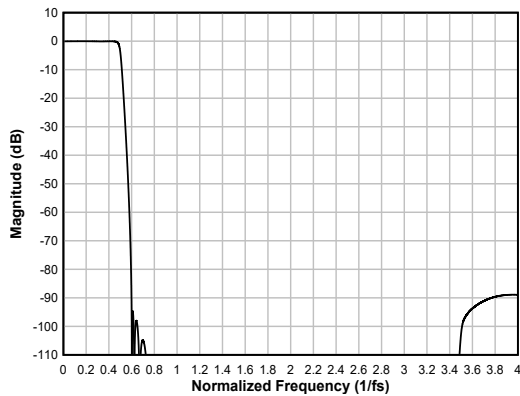


図 6-26. Low-latency Interpolation Filter Magnitude Response

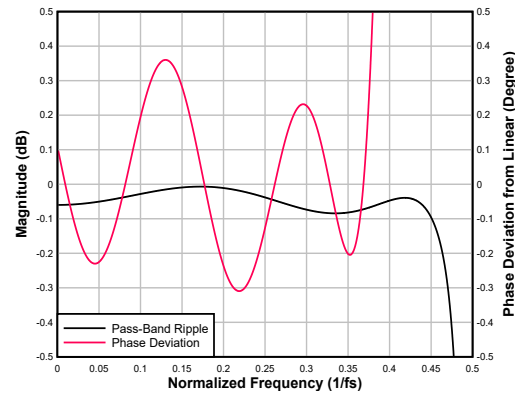


図 6-27. Low-latency Interpolation Filter Pass-Band Ripple and Phase Deviation

表 6-18. Low-latency Interpolation Filter Specifications

| PARAMETER              | TEST CONDITIONS   | MIN    | TYP  | MAX   | UNIT    |
|------------------------|---|--------|------|-------|---------|
| Pass-band ripple       | Frequency range is 0 to $0.455 \times f_s$              | -0.12  |      | -0.01 | dB      |
| Stop-band attenuation  | Frequency range is $0.599 \times f_s$ to $4 \times f_s$ | 88.9   |      |       | dB      |
|                        | Frequency range is $4 \times f_s$ to $7.414 \times f_s$ | 89     |      |       |         |
| Group delay or latency | Frequency range is 0 to $0.376 \times f_s$              |        | 7.19 |       | $1/f_s$ |
| Group delay deviation  | Frequency range is 0 to $0.376 \times f_s$              | -0.088 |      | 0.088 | $1/f_s$ |
| Phase deviation        | Frequency range is 0 to $0.376 \times f_s$              | -0.31  |      | 0.36  | Degrees |

#### 6.3.6.1.2.2 Sampling Rate: 32kHz or 29.4kHz

図 6-28 shows the magnitude response and 図 6-29 shows the pass-band ripple and phase deviation for this interpolation filter with a sampling rate of 32kHz or 29.4kHz. 表 6-19 lists its specifications.

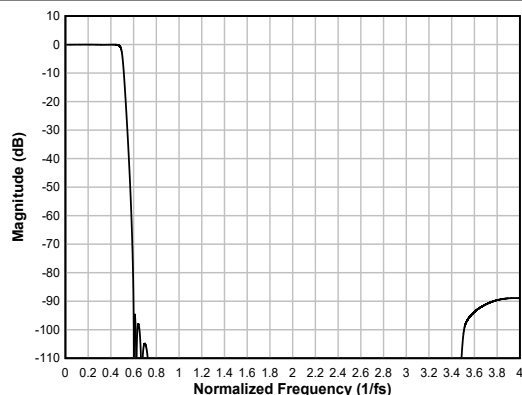


図 6-28. Low-latency Interpolation Filter Magnitude Response

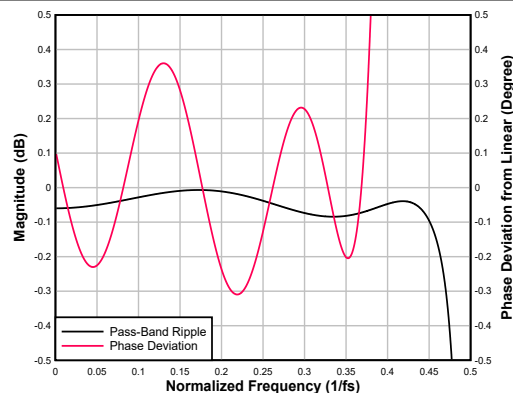


図 6-29. Low-latency Interpolation Filter Pass-Band Ripple and Phase Deviation

表 6-19. Low-latency Interpolation Filter Specifications

| PARAMETER              | TEST CONDITIONS   | MIN    | TYP  | MAX   | UNIT    |
|------------------------|---|--------|------|-------|---------|
| Pass-band ripple       | Frequency range is 0 to $0.455 \times f_S$              | -0.12  |      | -0.01 | dB      |
| Stop-band attenuation  | Frequency range is $0.599 \times f_S$ to $4 \times f_S$ | 88.9   |      |       | dB      |
|                        | Frequency range is $4 \times f_S$ to $7.414 \times f_S$ | 89     |      |       |         |
| Group delay or latency | Frequency range is 0 to $0.376 \times f_S$              |        | 7.19 |       | $1/f_S$ |
| Group delay deviation  | Frequency range is 0 to $0.376 \times f_S$              | -0.088 |      | 0.088 | $1/f_S$ |
| Phase deviation        | Frequency range is 0 to $0.376 \times f_S$              | -0.31  |      | 0.36  | Degrees |

#### 6.3.6.1.2.3 Sampling Rate: 48kHz or 44.1kHz

図 6-30 shows the magnitude response and 図 6-31 shows the pass-band ripple and phase deviation for this interpolation filter with a sampling rate of 48kHz or 44.1kHz. 表 6-20 lists its specifications.

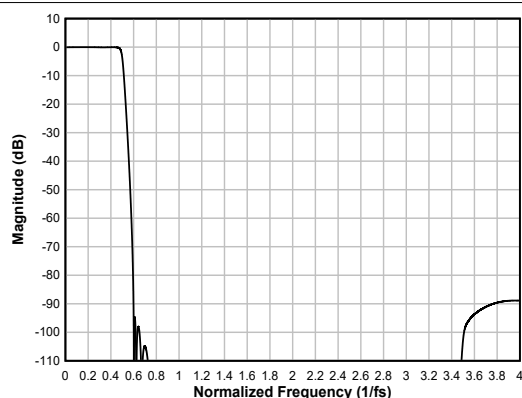


図 6-30. Low-latency Interpolation Filter Magnitude Response

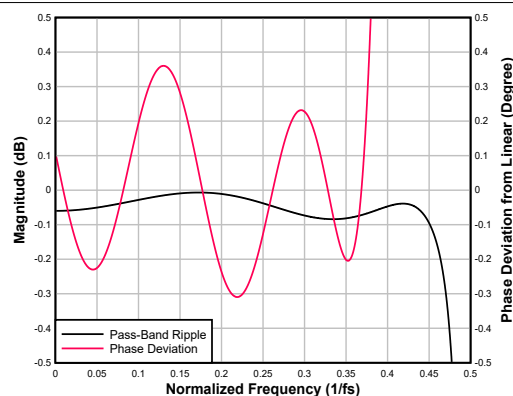


図 6-31. Low-latency Interpolation Filter Pass-Band Ripple and Phase Deviation

表 6-20. Low-latency Interpolation Filter Specifications

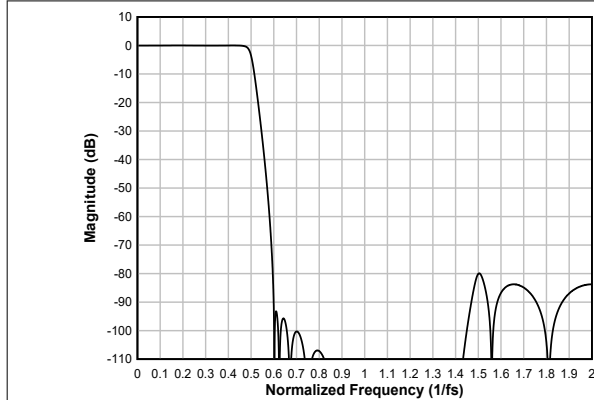
| PARAMETER              | TEST CONDITIONS   | MIN    | TYP  | MAX   | UNIT    |
|------------------------|---|--------|------|-------|---------|
| Pass-band ripple       | Frequency range is 0 to $0.455 \times f_S$              | -0.12  |      | -0.01 | dB      |
| Stop-band attenuation  | Frequency range is $0.599 \times f_S$ to $4 \times f_S$ | 88.9   |      |       | dB      |
|                        | Frequency range is $4 \times f_S$ to $7.414 \times f_S$ | 89     |      |       |         |
| Group delay or latency | Frequency range is 0 to $0.376 \times f_S$              |        | 7.19 |       | $1/f_S$ |
| Group delay deviation  | Frequency range is 0 to $0.376 \times f_S$              | -0.088 |      | 0.088 | $1/f_S$ |

**表 6-20. Low-latency Interpolation Filter Specifications (続き)**

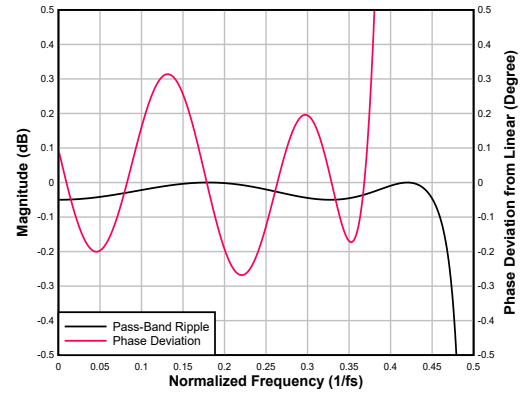
| PARAMETER       | TEST CONDITIONS                            | MIN   | TYP | MAX  | UNIT    |
|-----------------|--|-------|-----|------|---------|
| Phase deviation | Frequency range is 0 to $0.376 \times f_S$ | -0.31 |     | 0.36 | Degrees |

#### 6.3.6.1.2.4 Sampling Rate: 96kHz or 88.2kHz

図 6-32 shows the magnitude response and 図 6-33 shows the pass-band ripple and phase deviation for this interpolation filter with a sampling rate of 96kHz or 88.2kHz. 表 6-21 lists its specifications.



**図 6-32. Low-latency Interpolation Filter Magnitude Response**



**図 6-33. Low-latency Interpolation Filter Pass-Band Ripple and Phase Deviation**

**表 6-21. Low-latency Interpolation Filter Specifications**

| PARAMETER              | TEST CONDITIONS   | MIN    | TYP  | MAX   | UNIT    |
|------------------------|---|--------|------|-------|---------|
| Pass-band ripple       | Frequency range is 0 to $0.456 \times f_S$              | -0.07  |      | 0     | dB      |
| Stop-band attenuation  | Frequency range is $0.595 \times f_S$ to $2 \times f_S$ | 79.9   |      |       | dB      |
|                        | Frequency range is $2 \times f_S$ to $3.405 \times f_S$ | 79.9   |      |       |         |
| Group delay or latency | Frequency range is 0 to $0.376 \times f_S$              |        | 6.39 |       | $1/f_S$ |
| Group delay deviation  | Frequency range is 0 to $0.376 \times f_S$              | -0.078 |      | 0.022 | $1/f_S$ |
| Phase deviation        | Frequency range is 0 to $0.376 \times f_S$              | -0.268 |      | 0.022 | Degrees |

#### 6.3.6.1.2.5 Sampling Rate: 192kHz or 176.4kHz

図 6-34 shows the magnitude response and 図 6-35 shows the pass-band ripple and phase deviation for this interpolation filter with a sampling rate of 192kHz or 176.4kHz. 表 6-22 lists its specifications.

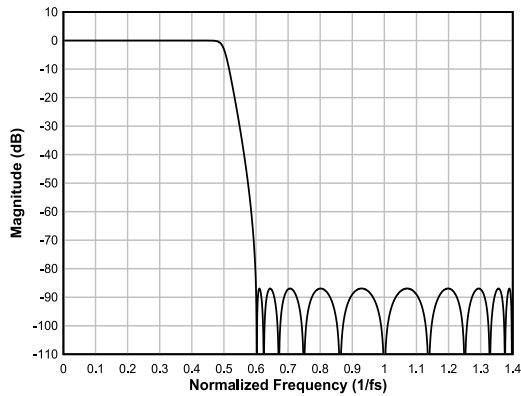


図 6-34. Low-latency Interpolation Filter Magnitude Response

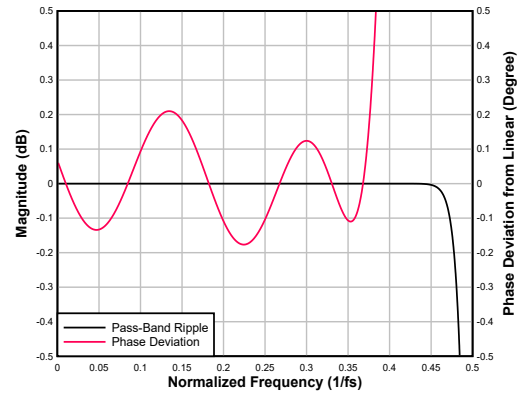


図 6-35. Low-latency Interpolation Filter Pass-Band Ripple and Phase Deviation

表 6-22. Low-latency Interpolation Filter Specifications

| PARAMETER              | TEST CONDITIONS   | MIN    | TYP  | MAX   | UNIT    |
|------------------------|---|--------|------|-------|---------|
| Pass-band ripple       | Frequency range is 0 to $0.452 \times f_S$              | -0.005 |      | 0     | dB      |
| Stop-band attenuation  | Frequency range is $0.6 \times f_S$ to $1 \times f_S$   | 86.9   |      |       | dB      |
|                        | Frequency range is $1 \times f_S$ to $1.401 \times f_S$ | 86.9   |      |       |         |
| Group delay or latency | Frequency range is 0 to $0.376 \times f_S$              |        | 5.41 |       | $1/f_S$ |
| Group delay deviation  | Frequency range is 0 to $0.376 \times f_S$              | -0.055 |      | 0.055 | $1/f_S$ |
| Phase deviation        | Frequency range is 0 to $0.376 \times f_S$              | -0.177 |      | 0.21  | Degrees |

## 6.4 Device Functional Modes

### 6.4.1 Active Mode

The device wakes up in active mode when AVDD and IOVDD are available. MD0 pin sets the type of audio serial interface and should be configured along with the supplies. Further, configure all other hardware control mode pins (MD1, MD2, MD3, MD4, MD5 and MD6) for the desired mode of operation before enabling the clocks for the device.

In active mode, when the audio clocks are available, the device automatically powers up the DAC channels and starts transmitting and playing data over the audio serial interface as per the configurations. If the clocks are stopped, then the device auto powers down the DAC channels.

Stopping the clocks or clock-error triggers an interrupt on the GPO pin. This is a latched interrupt that can be cleared by power-cycling the device supplies.



## 7 Application and Implementation

### 注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 7.1 Application Information

The TAD5142 is a pin or hardware controlled stereo, high-performance audio DAC that supports sample rates of up to 192kHz. The device can be configured by controlling the Mode pins MD0 to MD6 and can support 1.8V or 3.3V AVDD analog power supply along with flexible digital audio serial interfaces of I<sup>2</sup>S/TDM/LJ. The device also supports various output configurations like 2-channel differential, single-ended or psuedo-differential with external common-mode sense outputs with options for headphone and line-out drive capabilities.

### 7.2 Typical Application

#### 7.2.1 Application

図 7-1 shows a typical configuration of the TAD5142 for an application using a 2-channel differential line-out operation with a Target Mode I<sup>2</sup>S audio serial data interface.

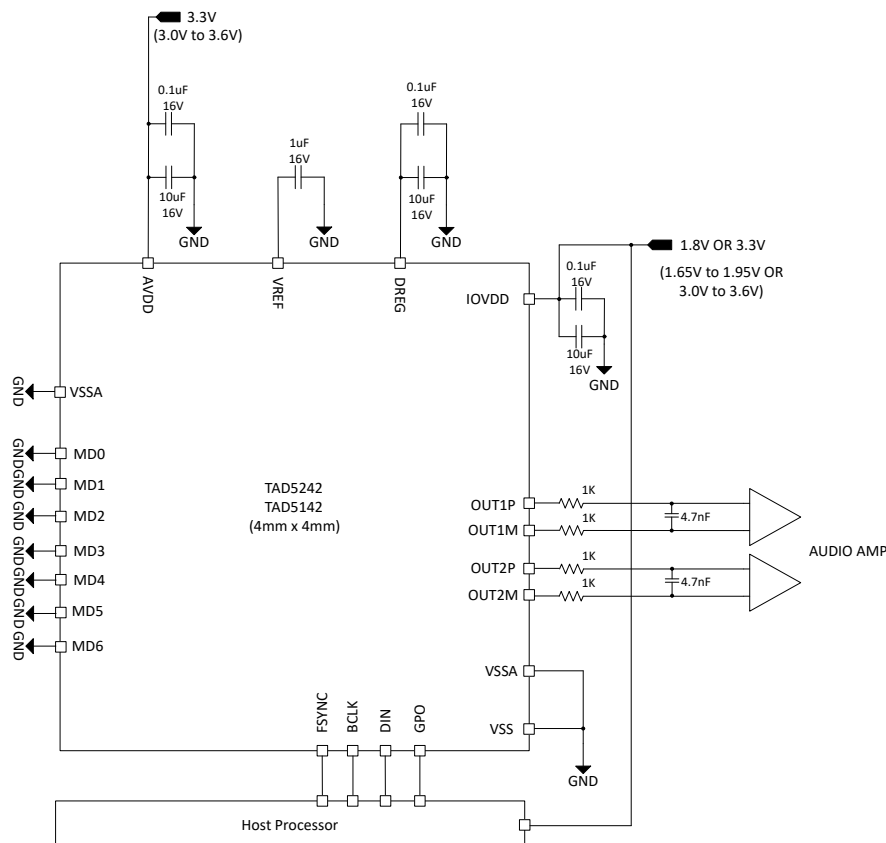


図 7-1. Stereo Differential Line-out in Target I<sup>2</sup>S Mode, Block Diagram

#### 7.2.2 Design Requirements

表 7-1 lists the typical design parameters for this application.

**表 7-1. Design Parameters**

| PARAMETER                          | VALUE                     |
|------------------------------------|---------------------------|
| AVDD                               | 1.8V or 3.3V              |
| IOVDD                              | 1.8V or 3.3V              |
| AVDD supply current consumption    | 17mA, with AVDD = 3.3V    |
| IOVDD supply current consumption   | 0.06mA, with IOVDD = 3.3V |
| Load on OUT1M, OUT1P, OUT2M, OUT2P | >600 ohms                 |

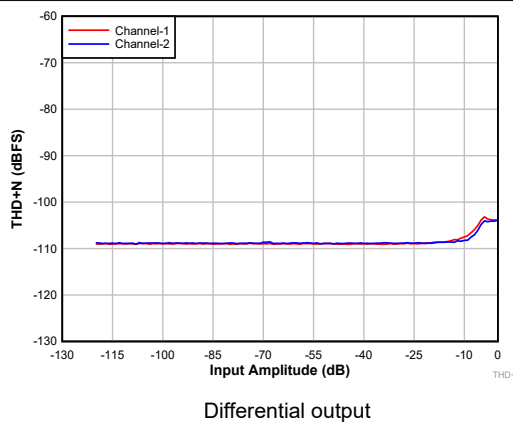
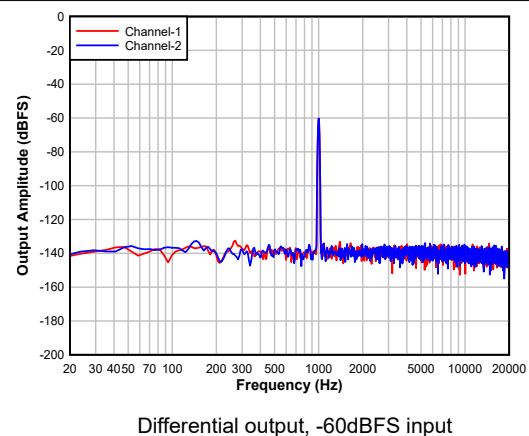
**7.2.3 Detailed Design Procedure**

This section describes the necessary steps to configure the TAD5142 for this specific application.

1. Audio serial interface (ASI) Mode is configured based on the MD0 pin setting which needs to be provided along with the power-supplies. Configure MD0 to be either pulled up to AVDD or down to VSS with appropriate resistor value. MD0 is configured to be grounded for this use case.
2. Apply power to the device:
  - a. Power up the IOVDD and AVDD power supplies.
  - b. Ensure that MD0 pin setting is stable as soon as power supplies are up and wait for at least 2ms to allow the device to initialize the internal registers for this mode of operation.
  - c. The device now is in sleep mode (low-power mode <1mA).
3. Configure the Mode pins MD1 to MD6 as per the system requirements:
  - a. Pull up to IOVDD or pull down to VSS on MD1 to MD6 pins as per the required configuration. All the pins are grounded for this use case.
4. Apply the ASI Clocks (BCLK and FSYNC) to wake up the device.
5. To put the device back in sleep mode, stop the clocks:
  - a. Wait at least 100ms to allow the device to complete the shutdown sequence.
  - b. Change the device mode configurations by changing MD1 to MD6 as per requirement.
6. To change the ASI mode, re-configure MD0 pin and power-cycle the device.
7. Repeat steps 1-6 as required for mode transitions.

**7.2.4 Application Performance Plots**

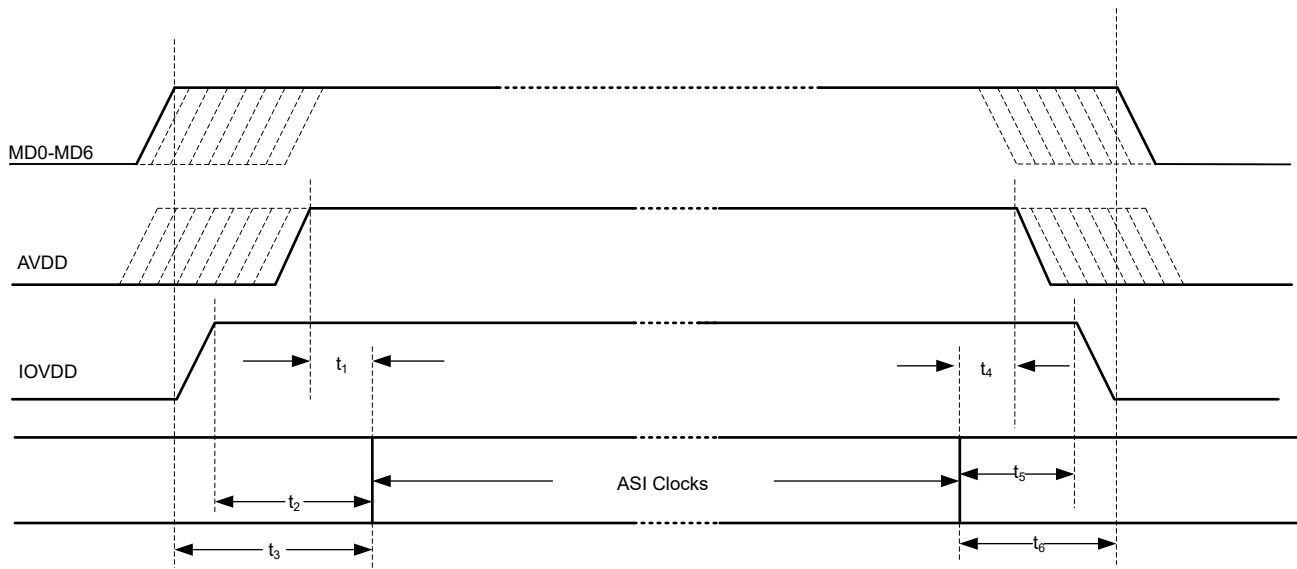
At  $T_A = 25^\circ\text{C}$ , AVDD = 3.3V, IOVDD = 3.3V,  $f_{IN} = 1\text{kHz}$  sinusoidal signal,  $f_S = 48\text{kHz}$ , 32-bit audio data, BCLK =  $256 \times f_S$ , TDM target mode, and linear phase interpolation filter, with  $1200\Omega$  line-out load in differential configuration; measured filter free with an Audio Precision with a 20Hz to 20kHz un-weighted bandwidth, unless otherwise noted

**図 7-2. DAC THD+N Level vs Input****図 7-3. DAC FFT**

## 7.3 Power Supply Recommendations

The power supply sequence between the IOVDD and AVDD rails can be applied in any order. MD0 pin should be provided along with the power supplies and should be stable as soon as the supplies are settled to the recommended operating voltage levels. Only initiate the clocks to initialize the device after all the other Mode pins (MD1 to MD6) are also stable.

For the supply power-up requirement,  $t_1$ ,  $t_2$  and  $t_3$  must be at least 2ms to allow the device to initialize the internal registers. See the [セクション 6.3.1](#) section for details on how the device operates in various modes after the device power supplies are settled to the recommended operating voltage levels. For the supply power-down requirement,  $t_4$ ,  $t_5$  and  $t_6$  must be at least 10ms. This timing (as shown in the [図 7-4](#)) allows the device to ramp down the volume on the playback data, power down the analog and digital blocks, and put the device into a low power mode.



**図 7-4. Power Supply Sequencing Requirement Timing Diagram**

Make sure that the supply ramp rate is slower than  $0.1\text{V}/\mu\text{s}$  and that the wait time between a power-down and a power-up event is at least 100ms.

The TAD5142 supports a single AVDD supply operation by integrating an on-chip digital regulator, DREG and integrated internal analog regulator.

## 7.4 Layout

### 7.4.1 Layout Guidelines

Each system design and printed circuit board (PCB) layout is unique. The layout must be carefully reviewed in the context of a specific PCB design. However, the following guidelines can optimize the device performance:

- Connect the thermal pad to ground. Use a via pattern to connect the device thermal pad, which is the area directly under the device, to the ground planes. This connection helps dissipate heat from the device.
- Use the same ground between VSS and VSSA to avoid any potential voltage difference between them.
- The decoupling capacitors for the power supplies must be placed close to the device pins.
- Route the analog differential audio signals differentially on the PCB for better noise immunity. Avoid crossing digital and analog signals to prevent undesirable crosstalk.
- Avoid running high-frequency clock and control signals near OUTxx pins where possible.
- The device internal voltage references must be filtered using external capacitors. Place the filter capacitors near the VREF pin for good performance.
- Provide a direct connection from the VREF external capacitor ground terminal to the VSS pin.

- Use ground planes to provide the lowest impedance for power and signal current between the device and the decoupling capacitors. Treat the area directly under the device as a central ground area for the device, and all device grounds must be connected directly to that area.

### 7.4.2 Layout Example

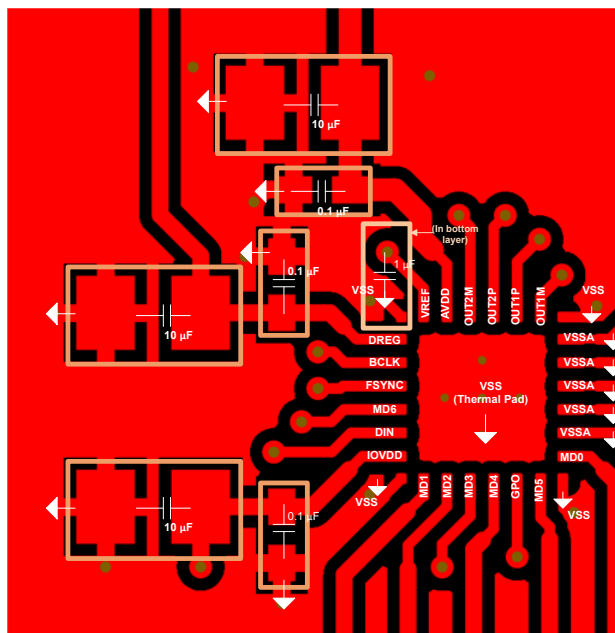


図 7-5. Example Layout

## 8 Device and Documentation Support

### 8.1 Documentation Support

#### 8.1.1 Related Documentation

For related documentation see the following:

- Texas Instruments, [TAx5x42EVM-K Hardware Control Evaluation Module User's Guide](#)

### 8.2 ドキュメントの更新通知を受け取る方法

ドキュメントの更新についての通知を受け取るには、[www.tij.co.jp](http://www.tij.co.jp) のデバイス製品フォルダを開いてください。[通知] をクリックして登録すると、変更されたすべての製品情報に関するダイジェストを毎週受け取ることができます。変更の詳細については、改訂されたドキュメントに含まれている改訂履歴をご覧ください。

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### 8.6 用語集

[テキサス・インスツルメンツ用語集](#)      この用語集には、用語や略語の一覧および定義が記載されています。

## 9 Revision History

資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

| Changes from Revision * (January 2024) to Revision A (October 2024) | Page |
|---|------|
| • デバイスのステータスを「量産データ」に更新。.....                                       | 1    |

## 10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TAD5142IRGER</a> | Active        | Production           | VQFN (RGE)   24 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | TAD5142             |
| TAD5142IRGER.A               | Active        | Production           | VQFN (RGE)   24 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | TAD5142             |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION

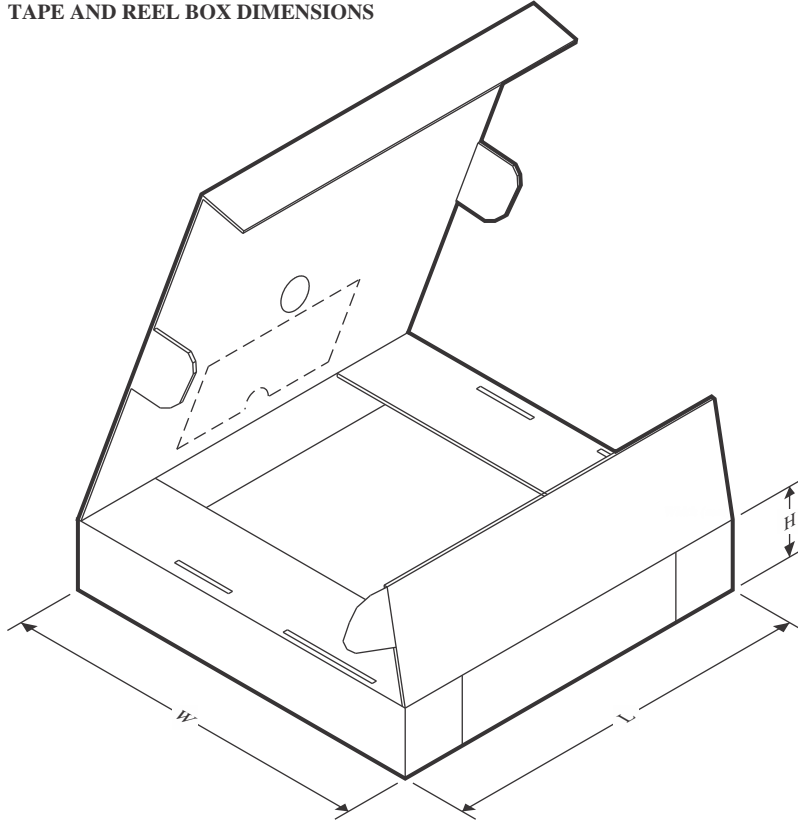


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TAD5142IRGER | VQFN         | RGE             | 24   | 3000 | 330.0              | 12.4               | 4.25    | 4.25    | 1.15    | 8.0     | 12.0   | Q2            |



## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

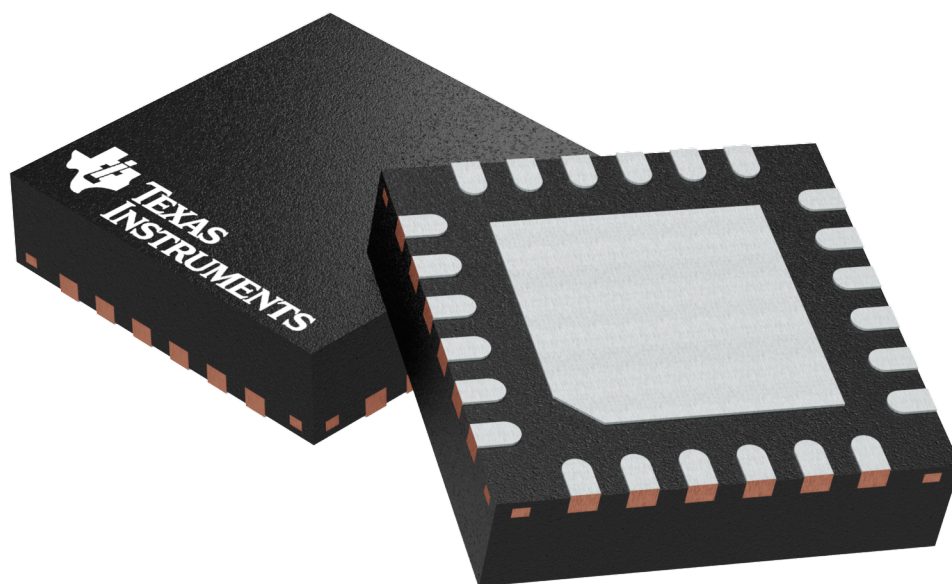
| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TAD5142IRGER | VQFN         | RGE             | 24   | 3000 | 367.0       | 367.0      | 35.0        |

**RGE 24**

**GENERIC PACKAGE VIEW**

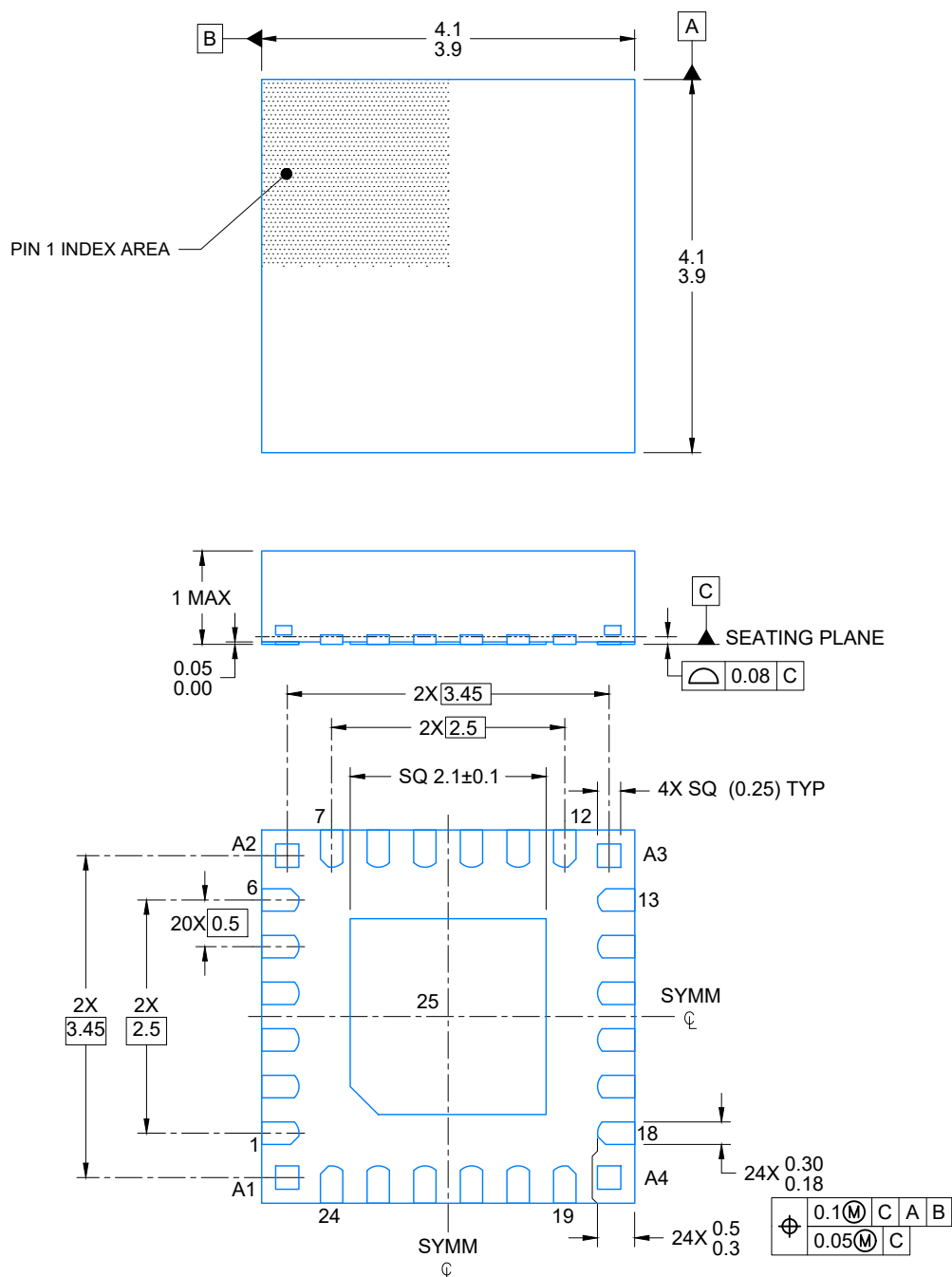
**VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

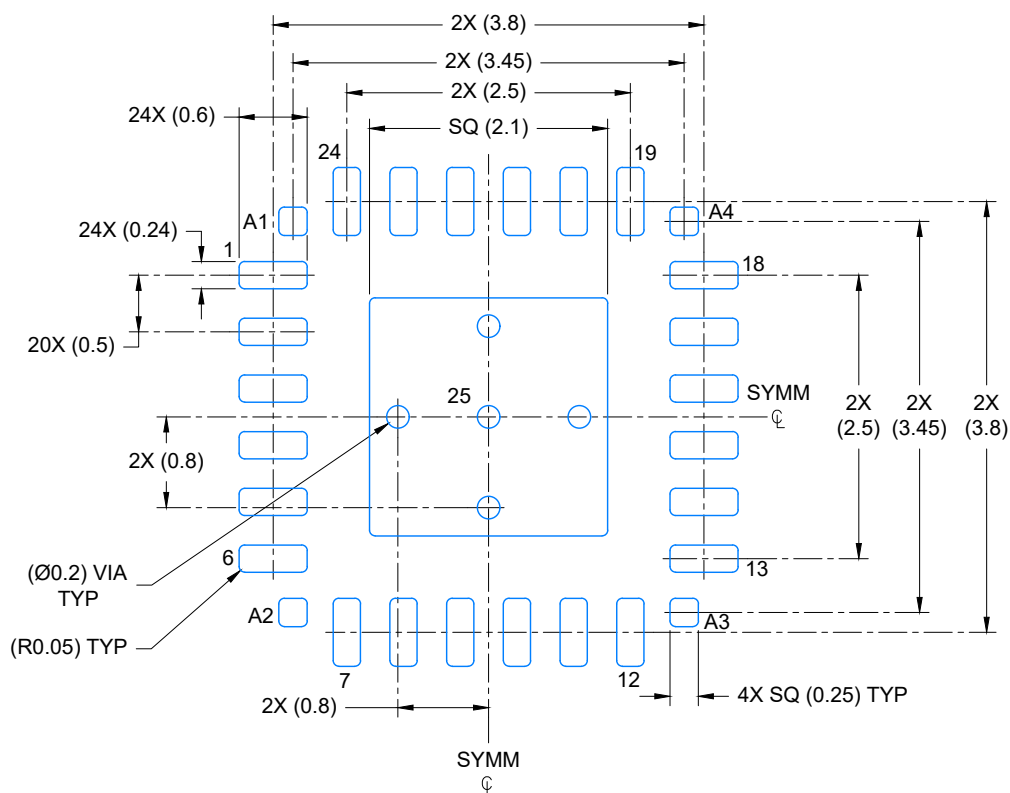
4204104/H



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## NOTES:

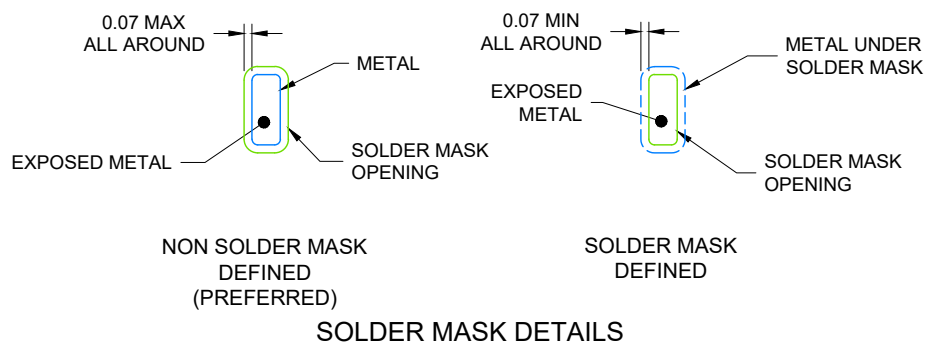
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for optimal thermal and mechanical performance.



## LAND PATTERN EXAMPLE

EXPOSED METAL SHOWN

SCALE: 15X



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## NOTES: (continued)

- This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slue271](http://www.ti.com/lit/slue271)).
- Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

### VQFN - 1 mm max height

Technical drawing of a 25-pin connector layout. The drawing shows a central 25-pin connector with dimensions in inches and millimeters. The layout is symmetrical about a vertical centerline (SYM) and a horizontal centerline (SYM).

Dimensions and labels:

- Overall width: 2X (3.8)
- Pin pitch (horizontal): 2X (3.45)
- Pin pitch (vertical): 2X (2.5)
- Pin pitch (diagonal): 4X SQ (0.94)
- Pin pitch (diagonal): 4X SQ (0.25) TYP
- Pin pitch (diagonal): 2X (0.57)
- Pin pitch (diagonal): 2X (0.5)
- Pin pitch (diagonal): 2X (0.24)
- Pin pitch (diagonal): 24X (0.6)
- Pin pitch (diagonal): 24X (0.24)
- Pin pitch (diagonal): 20X (0.5)
- Pin pitch (diagonal): 2X (0.57)
- Pin pitch (diagonal): 2X (2.5)
- Pin pitch (diagonal): 2X (3.45)
- Pin pitch (diagonal): 2X (3.8)

Labels and callouts:

- A1, A2, A3, A4: Pin locations
- 1, 6, 7, 12, 13, 18, 19, 25: Pin numbers
- 25: Pin number
- SYM: Symmetry line
- ℄: Right angle symbol
- (R0.05) TYP: Typical radius

EXPOSED PAD  
80% PRINTED COVERAGE BY AREA  
SCALE: 15X



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